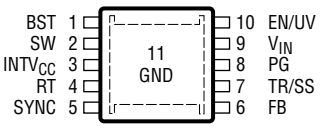
ABSOLUTE MAXIMUM RATINGS (Note 1)

V_{IN}, EN/UV, PG.....42V
FB, TR/SS 4V
SYNC, V_{OUT}.....6V

Operating Junction Temperature Range (Note 2)
LT8609E/LT8609AE/LT8609BE ..... –40°C to 125°C
LT8609I/LT8609AI/LT8609BI ..... –40°C to 125°C
LT8609H/LT8609AH ..... –40°C to 150°C
LT8609AJ ..... –40°C to 150°C
Storage Temperature Range ..... –65°C to 150°C

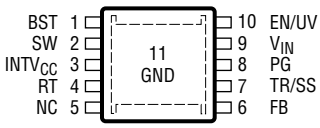
PIN CONFIGURATION

LT8609/LT8609A
TOP VIEW



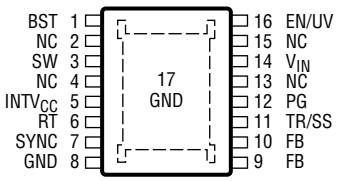
MSE PACKAGE
10-LEAD PLASTIC MSOP
θ_{JA} = 40°C/W
EXPOSED PAD (PIN 11) IS GND,
MUST BE SOLDERED TO PCB

LT8609B
TOP VIEW



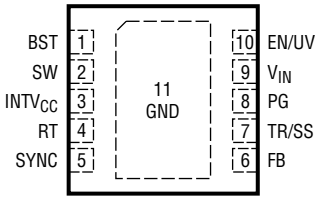
MSE PACKAGE
10-LEAD PLASTIC MSOP
θ_{JA} = 40°C/W
EXPOSED PAD (PIN 11) IS GND,
MUST BE SOLDERED TO PCB

LT8609A
TOP VIEW



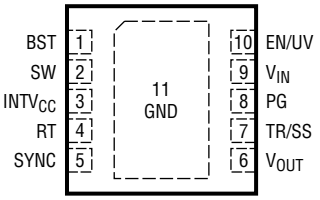
MS PACKAGE
16-LEAD PLASTIC MSOP
θ_{JA} = 40°C/W, θ_{JC}(PAD) = 10°C/W
EXPOSED PAD (PIN 17) IS GND,
MUST BE SOLDERED TO PCB

LT8609/LT8609A
TOP VIEW



DDM PACKAGE
10-LEAD (3mm × 3mm) PLASTIC SIDE WETTABLE DFN
θ_{JA} = 45°C/W, θ_{JC} = 10°C/W
EXPOSED PAD (PIN 11) IS GND, MUST BE SOLDERED TO PCB

LT8609-3.3/LT8609-5
TOP VIEW



DDM PACKAGE
10-LEAD (3mm × 3mm) PLASTIC SIDE WETTABLE DFN
θ_{JA} = 45°C/W, θ_{JC} = 10°C/W
EXPOSED PAD (PIN 11) IS GND, MUST BE SOLDERED TO PCB

ORDER INFORMATION

LEAD FREE FINISH	TAPE AND REEL	PART MARKING*	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LT8609EMSE#PBF	LT8609EMSE#TRPBF	LTGRW	10-Lead Plastic MSOP	–40°C to 125°C
LT8609IMSE#PBF	LT8609IMSE#TRPBF	LTGRW	10-Lead Plastic MSOP	–40°C to 125°C
LT8609HMSE#PBF	LT8609HMSE#TRPBF	LTGRW	10-Lead Plastic MSOP	–40°C to 150°C
LT8609AEMSE#PBF	LT8609AEMSE#TRPBF	LTGVR	10-Lead Plastic MSOP	–40°C to 125°C
LT8609AIMSE#PBF	LT8609AIMSE#TRPBF	LTGVR	10-Lead Plastic MSOP	–40°C to 125°C
LT8609AJMSE#PBF	LT8609AJMSE#TRPBF	LTGVR	10-Lead Plastic MSOP	–40°C to 150°C
LT8609AHMSE#PBF	LT8609AHMSE#TRPBF	LTGVR	10-Lead Plastic MSOP	–40°C to 150°C
LT8609BEMSE#PBF	LT8609BEMSE#TRPBF	LTGZY	10-Lead Plastic MSOP	–40°C to 125°C

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ORDER INFORMATION

LEAD FREE FINISH	TAPE AND REEL	PART MARKING*	PACKAGE DESCRIPTION	TEMPERATURE RANGE
LT8609BIMSE#PBF	LT8609BIMSE#TRPBF	LTGZY	10-Lead Plastic MSOP	–40°C to 125°C
LT8609AEMSE16#PBF	LT8609AEMSE16#TRPBF	8609A	16-Lead Plastic MSOP	–40°C to 125°C
LT8609AIMSE16#PBF	LT8609AIMSE16#TRPBF	8609A	16-Lead Plastic MSOP	–40°C to 125°C
LT8609AJMSE16#PBF	LT8609AJMSE16#TRPBF	8609A	16-Lead Plastic MSOP	–40°C to 150°C
LT8609AHMSE16#PBF	LT8609AHMSE16#TRPBF	8609A	16-Lead Plastic MSOP	–40°C to 150°C
LT8609AEDDM#PBF	LT8609AEDDM#TRPBF	LHJZ	10-Lead (3mm × 3mm) Plastic Side Wettable DFN	–40°C to 125°C
LT8609AJDDM#PBF	LT8609AJDDM#TRPBF	LHJZ	10-Lead (3mm × 3mm) Plastic Side Wettable DFN	–40°C to 150°C
LT8609AHDDM#PBF	LT8609AHDDM#TRPBF	LHJZ	10-Lead (3mm × 3mm) Plastic Side Wettable DFN	–40°C to 150°C
LT8609AEDDM-3.3#PBF	LT8609AEDDM-3.3#TRPBF	LHKB	10-Lead (3mm × 3mm) Plastic Side Wettable DFN	–40°C to 125°C
LT8609AJDDM-3.3#PBF	LT8609AJDDM-3.3#TRPBF	LHKB	10-Lead (3mm × 3mm) Plastic Side Wettable DFN	–40°C to 150°C
LT8609AEDDM-5#PBF	LT8609AEDDM-5#TRPBF	LHKC	10-Lead (3mm × 3mm) Plastic Side Wettable DFN	–40°C to 125°C
LT8609AJDDM-5#PBF	LT8609AJDDM-5#TRPBF	LHKC	10-Lead (3mm × 3mm) Plastic Side Wettable DFN	–40°C to 150°C
LT8609AHDDM-5#PBF	LT8609AHDDM-5#TRPBF	LHKC	10-Lead (3mm × 3mm) Plastic Side Wettable DFN	–40°C to 150°C
AUTOMOTIVE PRODUCTS**				
LT8609EMSE#WPBF	LT8609EMSE#WTRPBF	LTGRW	10-Lead Plastic MSOP	–40°C to 125°C
LT8609IMSE#WPBF	LT8609IMSE#WTRPBF	LTGRW	10-Lead Plastic MSOP	–40°C to 125°C
LT8609HMSE#WPBF	LT8609HMSE#WTRPBF	LTGRW	10-Lead Plastic MSOP	–40°C to 150°C
LT8609AEMSE#WPBF	LT8609AEMSE#WTRPBF	LTGVR	10-Lead Plastic MSOP	–40°C to 125°C
LT8609AIMSE#WPBF	LT8609AIMSE#WTRPBF	LTGVR	10-Lead Plastic MSOP	–40°C to 125°C
LT8609AJMSE#WPBF	LT8609AJMSE#WTRPBF	LTGVR	10-Lead Plastic MSOP	–40°C to 150°C
LT8609AHMSE#WPBF	LT8609AHMSE#WTRPBF	LTGVR	10-Lead Plastic MSOP	–40°C to 150°C
LT8609AEMSE16#WPBF	LT8609AEMSE16#WTRPBF	8609A	16-Lead Plastic MSOP	–40°C to 125°C
LT8609AIMSE16#WPBF	LT8609AIMSE16#WTRPBF	8609A	16-Lead Plastic MSOP	–40°C to 125°C
LT8609AJMSE16#WPBF	LT8609AJMSE16#WTRPBF	8609A	16-Lead Plastic MSOP	–40°C to 150°C
LT8609AHMSE16#WPBF	LT8609AHMSE16#WTRPBF	8609A	16-Lead Plastic MSOP	–40°C to 150°C
LT8609AEDDM#WPBF	LT8609AEDDM#WTRPBF	LHJZ	10-Lead (3mm × 3mm) Plastic Side Wettable DFN	–40°C to 125°C
LT8609AJDDM#WPBF	LT8609AJDDM#WTRPBF	LHJZ	10-Lead (3mm × 3mm) Plastic Side Wettable DFN	–40°C to 150°C
LT8609AHDDM#WPBF	LT8609AHDDM#WTRPBF	LHJZ	10-Lead (3mm × 3mm) Plastic Side Wettable DFN	–40°C to 150°C
LT8609AEDDM-3.3#WPBF	LT8609AEDDM-3.3#WTRPBF	LHKB	10-Lead (3mm × 3mm) Plastic Side Wettable DFN	–40°C to 125°C
LT8609AJDDM-3.3#WPBF	LT8609AJDDM-3.3#WTRPBF	LHKB	10-Lead (3mm × 3mm) Plastic Side Wettable DFN	–40°C to 150°C
LT8609AEDDM-5#WPBF	LT8609AEDDM-5#WTRPBF	LHKC	10-Lead (3mm × 3mm) Plastic Side Wettable DFN	–40°C to 125°C
LT8609AJDDM-5#WPBF	LT8609AJDDM-5#WTRPBF	LHKC	10-Lead (3mm × 3mm) Plastic Side Wettable DFN	–40°C to 150°C
LT8609AHDDM-5#WPBF	LT8609AHDDM-5#WTRPBF	LHKC	10-Lead (3mm × 3mm) Plastic Side Wettable DFN	–40°C to 150°C

Contact the factory for parts specified with wider operating temperature ranges. *The temperature grade is identified by a label on the shipping container.

Tape and reel specifications. Some packages are available in 500 unit reels through designated sales channels with #TRMPBF suffix.

**Versions of this part are available with controlled manufacturing to support the quality and reliability requirements of automotive applications. These models are designated with a #W suffix. Only the automotive grade products shown are available for use in automotive applications. Contact your local Analog Devices account representative for specific product ordering information and to obtain the specific Automotive Reliability reports for these models.

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ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_A = 25°C.

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Minimum Input Voltage					3.0	V
		●		2.7	3.2	
V_{IN} Quiescent Current	LT8609/LT8609A:					
	$V_{EN/UV}$ = 0V, V_{SYNC} = 0V			1	4	µA
	$V_{EN/UV}$ = 2V, Not Switching, V_{SYNC} = 0V	●		1.7	12	µA
	LT8609B:					
	$V_{EN/UV}$ = 0V			1	4	µA
	$V_{EN/UV}$ = 2V, Not Switching			350		µA
V_{IN} Current in Regulation	LT8609/LT8609A:					
	V_{IN} = 6V, V_{OUT} = 2.7V, Output Load = 100µA	●		46	90	µA
	V_{IN} = 6V, V_{OUT} = 2.7V, Output Load = 1mA	●		480	700	µA
	LT8609A-3.3:					
	V_{IN} = 8V, V_{OUT} = 3.3V I_{LOAD} = 100µA	●		46	90	µA
	V_{IN} = 8V, V_{OUT} = 3.3V I_{LOAD} = 1mA	●		480	700	µA
	LT8609A-5:					
	V_{IN} = 12V, V_{OUT} = 5V I_{LOAD} = 100µA	●		46	90	µA
	V_{IN} = 12V, V_{OUT} = 5V I_{LOAD} = 1mA	●		480	700	µA
Feedback Reference Voltage	LT8609/LT8609A: (E-, I-, H-Grade)					
	V_{IN} = 6V, I_{LOAD} = 100mA		0.778	0.782	0.786	V
	V_{IN} = 6V, I_{LOAD} = 100mA	●	0.770	0.782	0.794	V
	LT8609/LT8609A: (J-Grade)					
	V_{IN} = 6V, I_{LOAD} = 100mA		0.778	0.782	0.786	V
	V_{IN} = 6V, I_{LOAD} = 100mA	●	0.766	0.782	0.798	V
	LT8609B:					
	V_{IN} = 6V, I_{LOAD} = 100mA		0.772	0.782	0.792	V
	V_{IN} = 6V, I_{LOAD} = 100mA	●	0.759	0.782	0.805	V
Output Reference Voltage	LT8609A-3.3:					
	V_{IN} = 8V, I_{LOAD} = 100mA		3.291	3.3	3.309	V
	V_{IN} = 8V, I_{LOAD} = 100mA	●	3.25	3.3	3.35	V
	LT8609A-5:					
	V_{IN} = 12V, I_{LOAD} = 100mA		4.97	5	5.03	V
	V_{IN} = 12V, I_{LOAD} = 100mA	●	4.89	5	5.11	V
Feedback Voltage Line Regulation	LT8609/LT8609A:					
	V_{IN} = 4.0V to 40V	●		0.004	0.02	%/V
Feedback Voltage Line Regulation	LT8609B:					
	V_{IN} = 4.0V to 40V	●		0.004	0.04	%/V
Output Voltage Line Regulation	LT8609A-3.3:					
	V_{IN} = 4.0V to 40V	●		0.004	0.02	%/V
Output Voltage Line Regulation	LT8609A-5:					
	V_{IN} = 6.0V to 40V	●		0.004	0.02	%/V
Feedback Pin Input Current	LT8609/LT8609A/LT8609B:					
	V_{FB} = 1.0V	●			±20	nA
Output Pin Input Current	LT8609A-3.3:					
	V_{OUT} = 4.0V	●		620		nA
Output Pin Input Current	LT8609A-5:					
	V_{OUT} = 6.0V	●		425		nA
Minimum On-Time	I_{LOAD} = 1.5A, SYNC = 0V	●		45	75	ns
	I_{LOAD} = 1.5A, SYNC = 1.9V	●		45	60	ns
Minimum Off Time				90	130	ns

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ELECTRICAL CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T_A = 25°C.

PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
Oscillator Frequency	LT8609/LT8609A:					
	R_T = 221k, I_{LOAD} = 0.5A	●	155	200	245	kHz
	R_T = 60.4k, I_{LOAD} = 0.5A	●	640	700	760	kHz
	R_T = 18.2k, I_{LOAD} = 0.5A	●	1.925	2.00	2.075	MHz
	LT8609B:					
	R_T = 18.2k, I_{LOAD} = 0.5A	●	1.875	2.00	2.125	MHz
Top Power NMOS On-Resistance	I_{LOAD} = 1A			185		mΩ
Top Power NMOS Current Limit		●	3.4	4.5	5.7	A
Bottom Power NMOS On-Resistance				115		mΩ
SW Leakage Current	V_{IN} = 42V, V_{SW} = 40V	●			15	µA
EN/UV Pin Threshold	EN/UV Rising	●	0.99	1.05	1.11	V
EN/UV Pin Hysteresis				50		mV
EN/UV Pin Current	LT8609/LT8609A:					
	$V_{EN/UV}$ = 2V	●			±20	nA
	LT8609B:					
	$V_{EN/UV}$ = 2V	●			±30	nA
PG Upper Threshold Offset from V_{FB}	LT8609/LT8609A:					
	V_{FB} Rising	●	5	8.5	13	%
	LT8609B:					
	V_{FB} Rising	●	4	8.5	14	%
PG Upper Threshold Offset from V_{OUT}	LT8609A-3.3/LT8609A-5					
	V_{OUT} Rising	●	5	7.5	11	%
PG Lower Threshold Offset from V_{FB}	LT8609/LT8609A:					
	V_{FB} Falling	●	5	8.5	13	%
	LT8609B:					
	V_{FB} Falling	●	4	8.5	14	%
PG Lower Threshold Offset from V_{OUT}	LT8609A-3.3/LT8609A-5					
	V_{OUT} Falling	●	5	7.5	11	%
PG Hysteresis				0.5		%
PG Leakage	V_{PG} = 42V	●			±200	nA
PG Pull-Down Resistance	V_{PG} = 0.1V			550	1200	Ω
Sync Low Input Voltage	LT8609/LT8609A	●	0.4	0.9		V
Sync High Input Voltage	LT8609/LT8609A:	●		2.7	3.2	V
	$INTV_{CC}$ = 3.5V					
TR/SS Source Current		●	1	2	3	µA
TR/SS Pull-Down Resistance	Fault Condition, TR/SS = 0.1V			300	900	Ω
Spread Spectrum Modulation Frequency	LT8609/LT8609A:					
	V_{SYNC} = 3.3V		1	3	6	kHz

Note 1: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime. Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

Note 2: The LT8609E/LT8609AE/LT8609BE is guaranteed to meet performance specifications from 0°C to 125°C junction temperature. Specifications over the –40°C to 125°C operating junction temperature range are assured by design, characterization, and correlation with statistical process controls. The LT8609I/LT8609AI/LT8609BI is guaranteed over the full –40°C to 125°C operating junction temperature range. The LT8609H/LT8609AH/LT8609AJ is guaranteed over the full –40°C to 150°C operating junction temperature range. High junction temperatures degrade operating lifetimes. Operating lifetime is derated at junction temperatures greater than 125°C.

Note 3: This IC includes overtemperature protection that is intended to protect the device during overload conditions. Junction temperature will exceed 150°C when overtemperature protection is active. Continuous operation above the specified maximum operating junction temperature will reduce lifetime.

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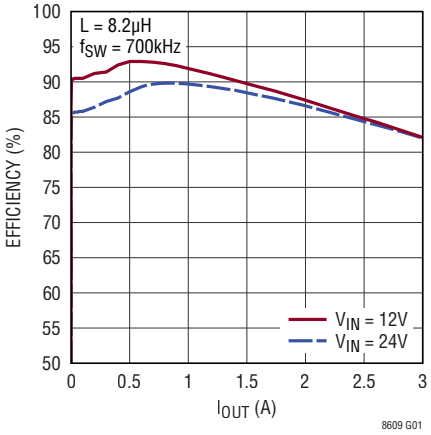
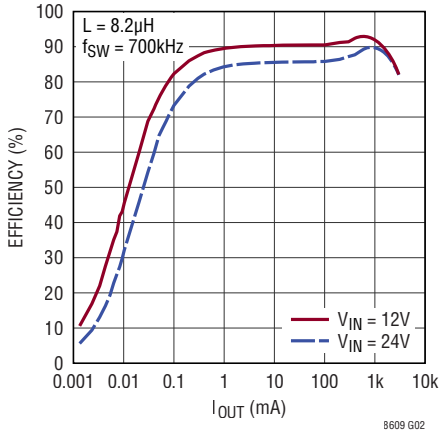
TYPICAL PERFORMANCE CHARACTERISTICS

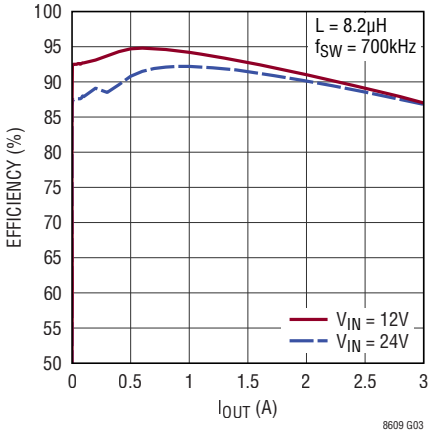
LT8609 Efficiency (3.3V Output, Burst Mode Operation)



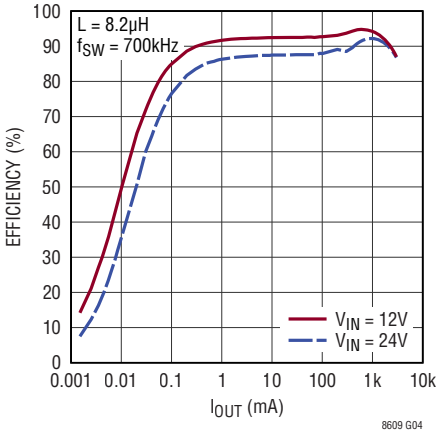
LT8609 Efficiency (3.3V Output, Burst Mode Operation)



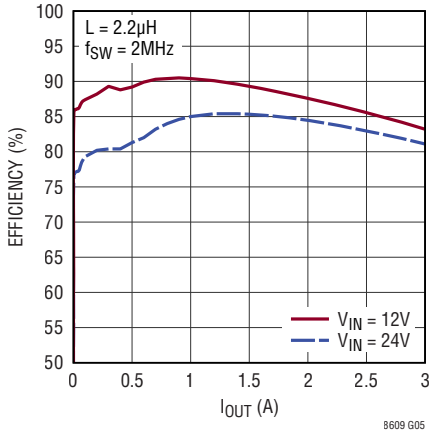
LT8609 Efficiency (5V Output, Burst Mode Operation)



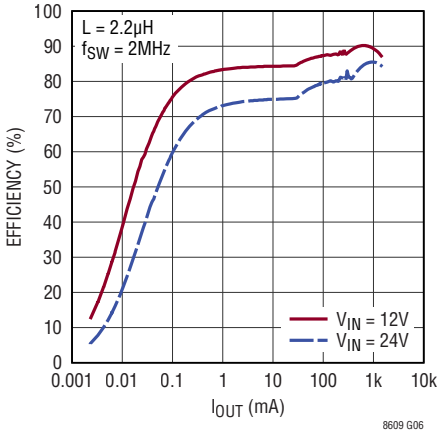
LT8609 Efficiency (5V Output, Burst Mode Operation)



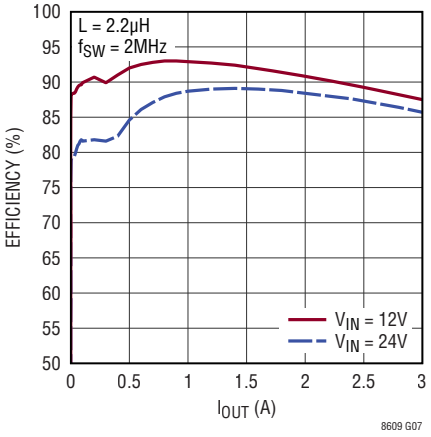
LT8609 Efficiency (3.3V Output, 2MHz, Burst Mode Operation)



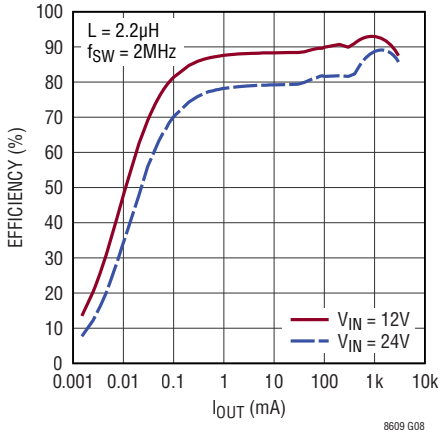
LT8609 Efficiency (3.3V Output, 2MHz, Burst Mode Operation)



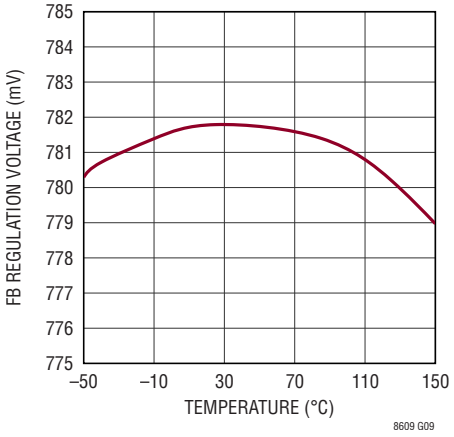
LT8609 Efficiency (5V Output, 2MHz, Burst Mode Operation)



LT8609 Efficiency (5V Output, 2MHz, Burst Mode Operation)



FB Voltage



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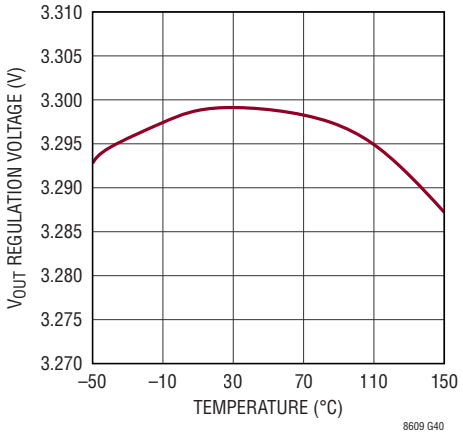
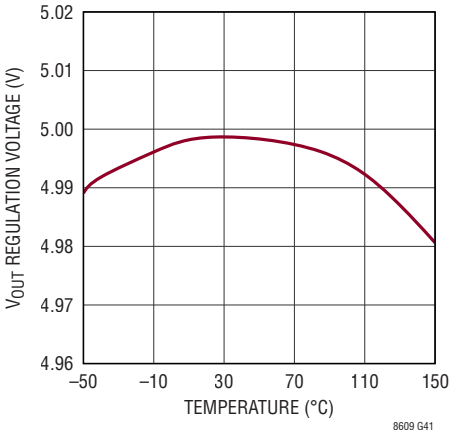
TYPICAL PERFORMANCE CHARACTERISTICS

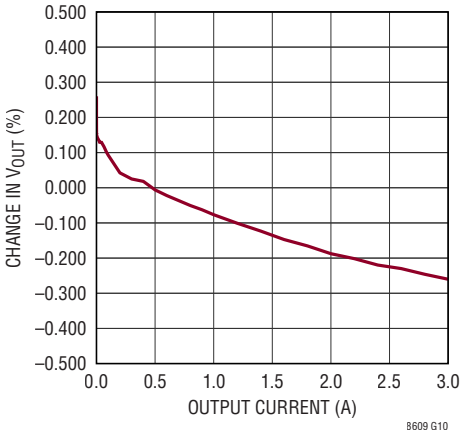
LT8609A-3.3 V_{OUT} Voltage



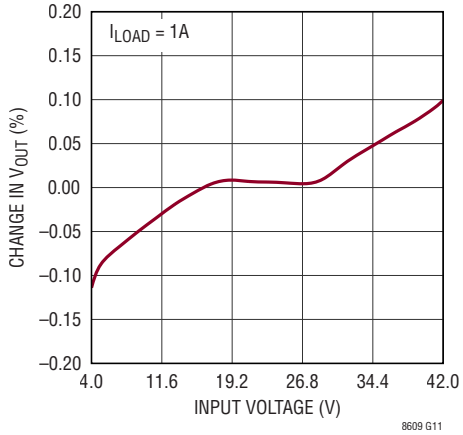
LT8609A-5 V_{OUT} Voltage



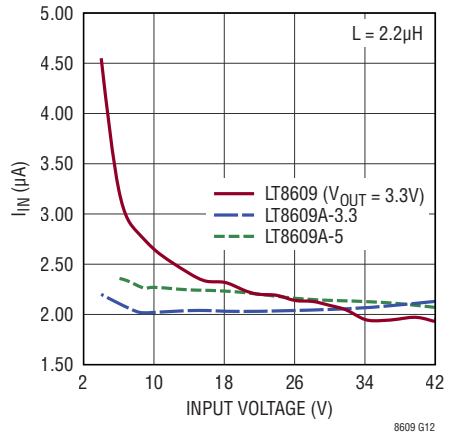
Load Regulation



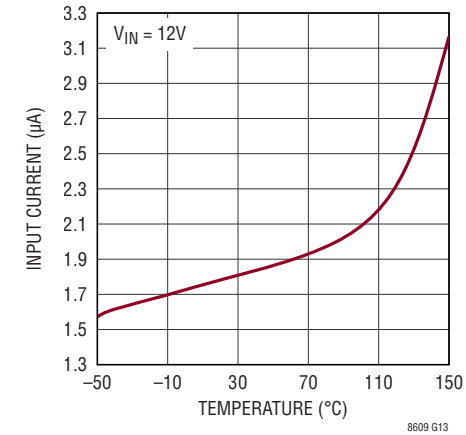
Line Regulation



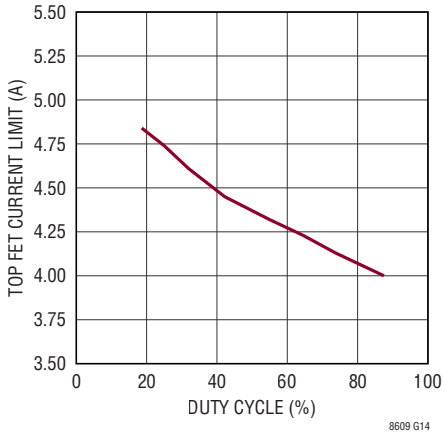
No-Load Supply Current Tested in Regulation



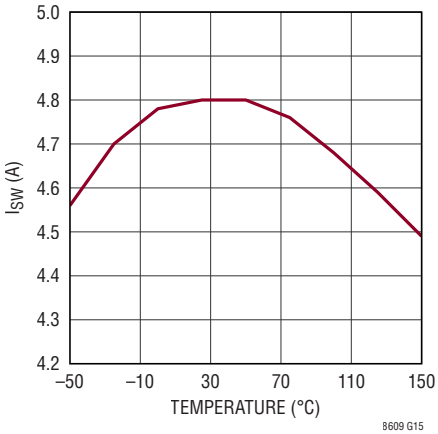
No-Load Supply Current vs Temperature (Not Switching)



Top FET Current Limit vs Duty Cycle



Top FET Current Limit vs Temperature



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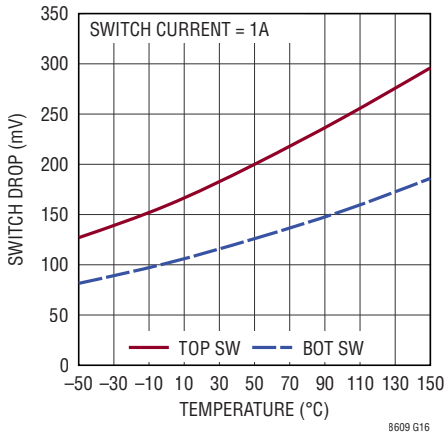
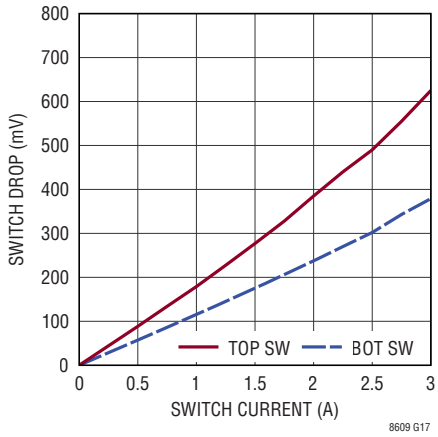
TYPICAL PERFORMANCE CHARACTERISTICS

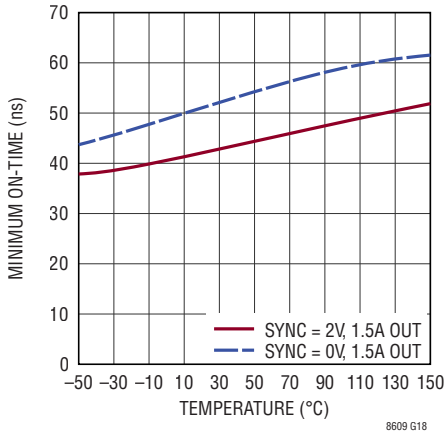
Switch Drop vs Temperature



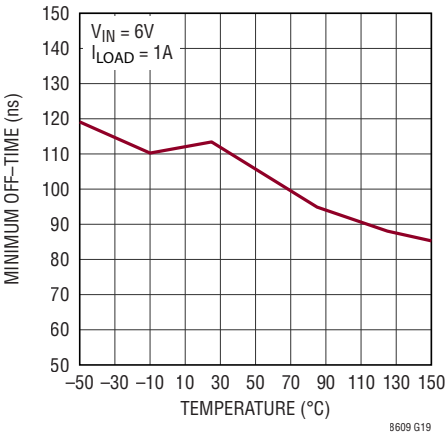
Switch Drop vs Switch Current



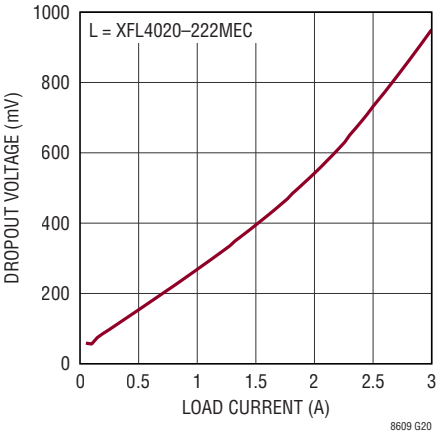
Minimum On-Time vs Temperature



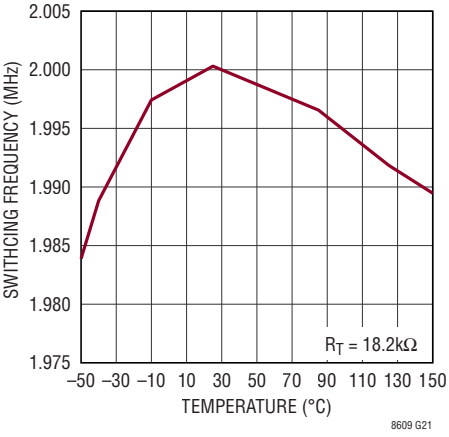
Minimum Off-Time vs Temperature



Dropout Voltage vs Load Current



Switching Frequency vs Temperature



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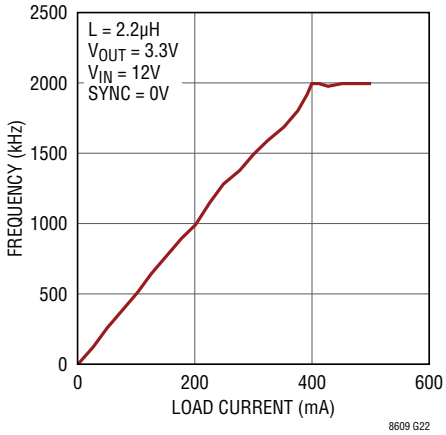
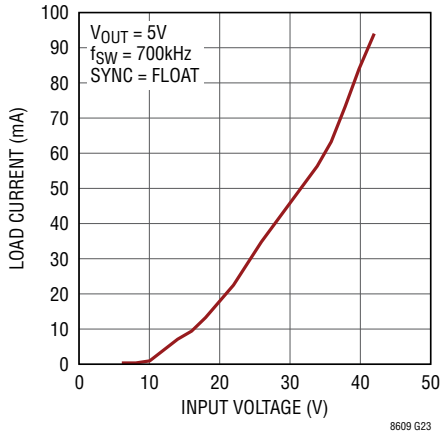
TYPICAL PERFORMANCE CHARACTERISTICS

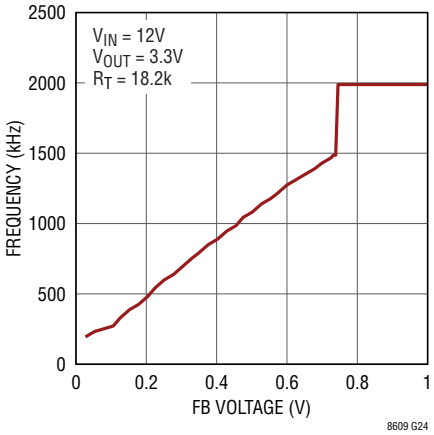
Burst Frequency vs Load Current



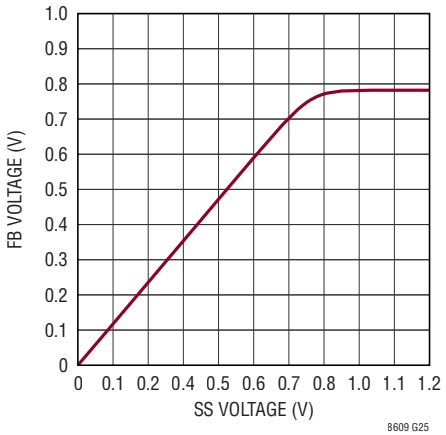
Minimum Load to Full Frequency (SYNC Float to 1.9V)



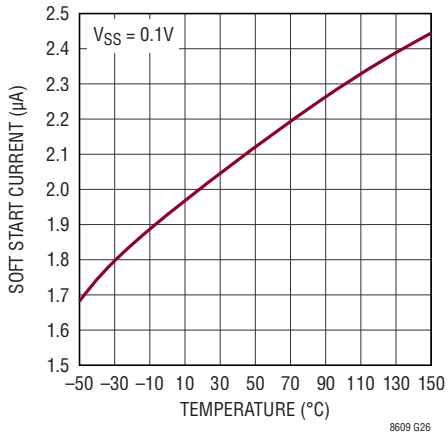
Frequency Foldback



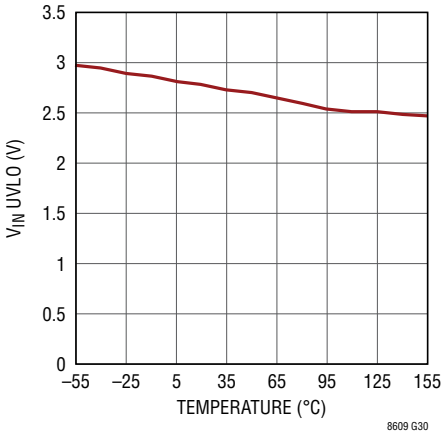
Soft-Start Tracking



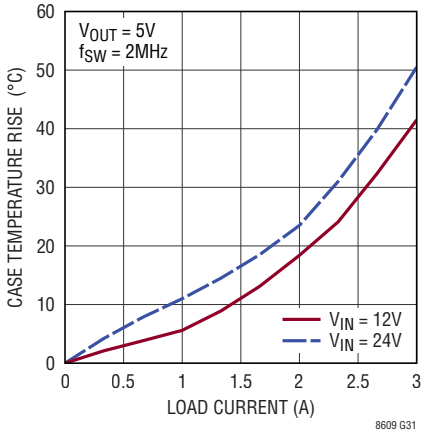
Soft-Start Current vs Temperature



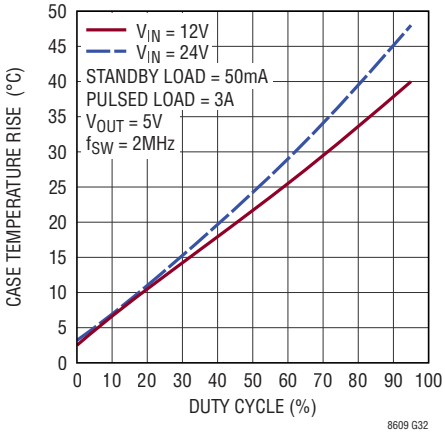
V_{IN} UVLO



Case Temperature vs Load Current



Case Temperature vs 3A Pulsed Load



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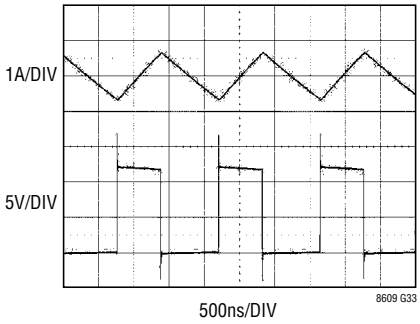
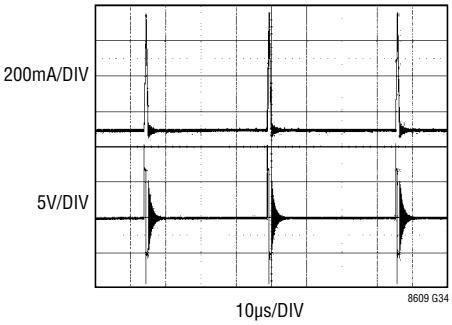
TYPICAL PERFORMANCE CHARACTERISTICS

Switching Waveforms



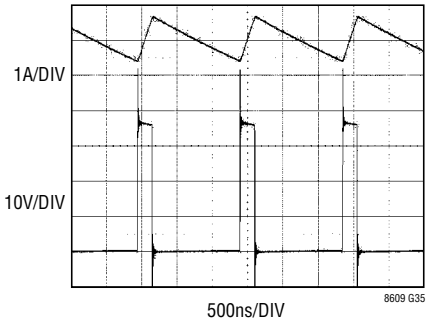
$12V_{IN}$ TO $5V_{OUT}$ AT 1A

Switching Waveforms



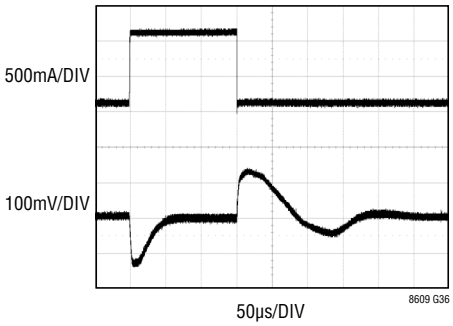
$12V_{IN}$ TO $5V_{OUT}$ AT 10mA
SYNC = 0

Switching Waveforms



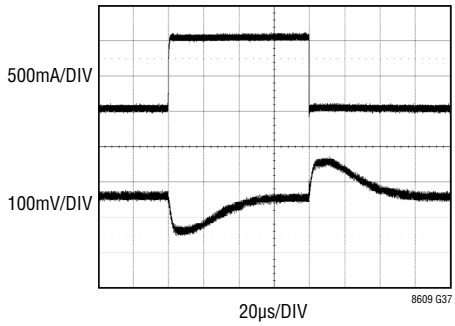
$36V_{IN}$ TO $5V_{OUT}$ AT 1A

Transient Response



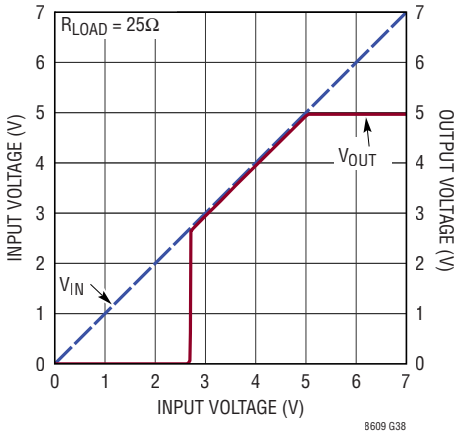
50mA TO 1A TRANSIENT
$12V_{IN}$ TO $5V_{OUT}$
C_{OUT} = 47µF

Transient Response

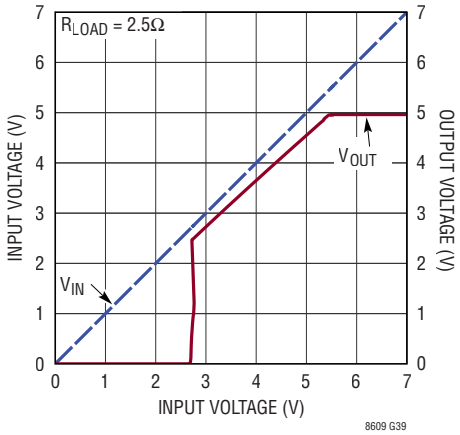


0.5A TO 1.5A TRANSIENT
$12V_{IN}$ TO $5V_{OUT}$
C_{OUT} = 47µF

Start-Up Dropout



Start-Up Dropout



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PIN FUNCTIONS

BST: This pin is used to provide a drive voltage, higher than the input voltage, to the topside power switch. Place a 0.1µF boost capacitor as close as possible to the IC. Do not place a resistor in series with this pin.

SW: The SW pin is the output of the internal power switches. Connect this pin to the inductor and boost capacitor. This node should be kept small on the PCB for good performance.

$INTV_{CC}$: Internal 3.5V Regulator Bypass Pin. The internal power drivers and control circuits are powered from this voltage. $INTV_{CC}$ max output current is 20mA. Voltage on $INTV_{CC}$ will vary between 2.8V and 3.5V. Decouple this pin to power ground with at least a 1µF low ESR ceramic capacitor. Do not load the $INTV_{CC}$ pin with external circuitry.

RT: A resistor is tied between RT and ground to set the switching frequency.

SYNC: External Clock Synchronization Input. Ground this pin for low ripple Burst Mode operation at low output loads. Tie to a clock source for synchronization to an external frequency. Leave floating for pulse-skipping mode with no spread spectrum modulation. Tie to $INTV_{CC}$ or tie to a voltage between 3.2V and 5.0V for pulse-skipping mode with spread spectrum modulation. When in pulse-skipping mode, the I_Q will increase to several mA. In the LT8609B, the SYNC pin is replaced with a no connect; the LT8609B operates in pulse-skipping mode without spread spectrum.

FB (LT8609/LT8609A/LT8609B ONLY): The LT8609/LT8609A/LT8609B adjustable output parts regulate the FB pin to 0.782V. Connect the feedback resistor divider tap to this pin.

V_{OUT} (LT8609A-3.3/LT8609-5 ONLY): The LT 8609A-3.3 regulates to V_{OUT} pin to 3.3V. This pin connects a 5.9MΩ internal feedback divider that programs the fixed output. The LT8609A-5 regulates to V_{OUT} pin to 5V. This pin connects a 8.95MΩ internal feedback divider that programs the fixed output.

TR/SS: Output Tracking and Soft-Start Pin. This pin allows user control of output voltage ramp rate during start-up. A TR/SS voltage below 0.782V forces the LT8609/LT8609A/LT8609B to regulate the FB pin to equal the TR/SS pin voltage. In the LT8609A-3.3 and LT8609A-5 fixed output voltage options the output voltage will track the TR/SS pin voltage based on a factor set by the internal feedback resistor divider. The 3.3V output options will track to a voltage 4.2 times that of the TR/SS pin, while the 5V output options will track to a voltage 6.39 times that of the TR/SS pin. When TR/SS is above 0.782V, the tracking function is disabled and the internal reference resumes control of the error amplifier. An internal 2µA pull-up current from $INTV_{CC}$ on this pin allows a capacitor to program output voltage slew rate. This pin is pulled to ground with a 300Ω MOSFET during shutdown and fault conditions; use a series resistor if driving from a low impedance output.

PG: The PG pin is the open-drain output of an internal comparator. On the LT8609/LT8609A/LT8609B adjustable output parts, PG remains low until the FB pin is within ±8.5% of the final regulation voltage, and there are no fault conditions. On the LT8609A-3.3/LT8609A-5 fixed output parts, PG remains low until the V_{OUT} pin is within ±7.5% of the final regulation voltage, and there are no fault conditions. PG is valid when V_{IN} is above 3.2V, regardless of EN/UV pin state.

V_{IN}: The V_{IN} pin supplies current to the LT8609/LT8609A/LT8609B internal circuitry and to the internal topside power switch. This pin must be locally bypassed. Be sure to place the positive terminal of the input capacitor as close as possible to the V_{IN} pins, and the negative capacitor terminal as close as possible to the GND pins.

EN/UV: The LT8609/LT8609A/LT8609B is shut down when this pin is low and active when this pin is high. The hysteretic threshold voltage is 1.05V going up and 1.00V going down. Tie to V_{IN} if the shutdown feature is not used. An external resistor divider from V_{IN} can be used to program a V_{IN} threshold below which the LT8609/LT8609A/LT8609B will shut down.

GND: Exposed Pad Pin. The exposed pad must be connected to the negative terminal of the input capacitor and soldered to the PCB in order to lower the thermal resistance.

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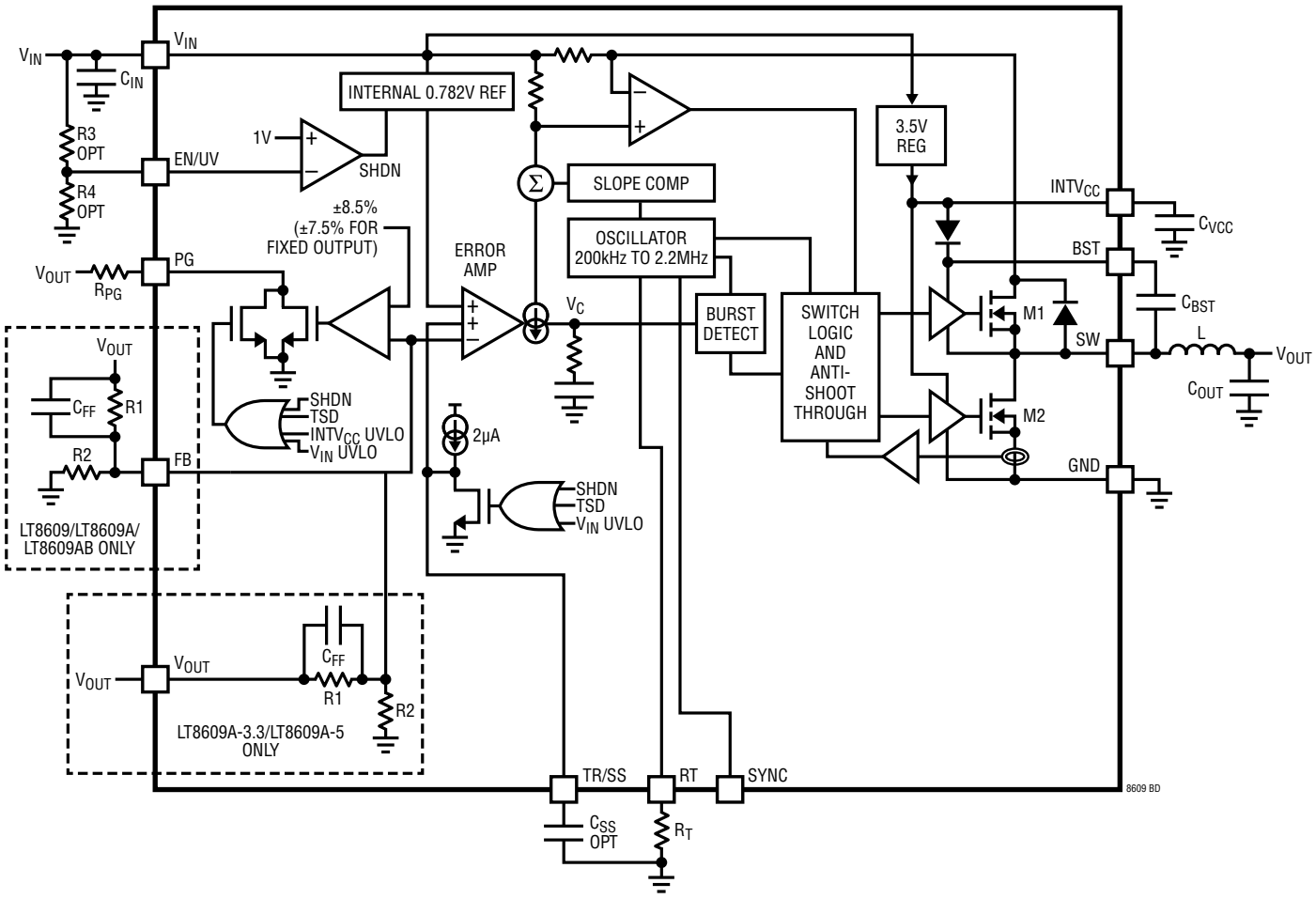
BLOCK DIAGRAM



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OPERATION

The LT8609/LT8609A/LT8609B is a monolithic constant frequency current mode step-down DC/DC converter. An oscillator with frequency set using a resistor on the RT pin turns on the internal top power switch at the beginning of each clock cycle. Current in the inductor then increases until the top switch current comparator trips and turns off the top power switch. The peak inductor current at which the top switch turns off is controlled by the voltage on the internal VC node. The error amplifier servos the VC node by comparing the voltage on the V_{FB} pin with an internal 0.782V reference. The LT8609A-5 and LT8609A-3.3 Fixed output parts use the V_{OUT} pin and an internal resistor divider to generate an internal FB node. When the load current increases it causes a reduction in the feedback voltage relative to the reference leading the error amplifier to raise the VC voltage until the average inductor current matches the new load current. When the top power switch turns off the synchronous power switch turns on until the next clock cycle begins or inductor current falls to zero. If overload conditions result in excess current flowing through the bottom switch, the next clock cycle will be delayed until switch current returns to a safe level.

If the EN/UV pin is low, the LT8609/LT8609A/LT8609B is shut down and draws 1µA from the input. When the EN/UV pin is above 1V, the switching regulator becomes active.

To optimize efficiency at light loads, the LT8609/LT8609A enters Burst Mode operation during light load situations. Between bursts, all circuitry associated with controlling the output switch is shut down, reducing the input supply current to 1.7µA. In a typical application, 2.5µA will be consumed from the input supply when regulating with no load. The SYNC pin is tied low to use Burst Mode operation and can be floated to use pulse-skipping mode. If a clock is applied to the SYNC pin the part will synchronize to an external clock frequency and operate in pulse-skipping mode. While in pulse-skipping mode the oscillator operates continuously and positive SW transitions are aligned to the clock. During light loads, switch pulses are skipped to regulate the output and the quiescent current will be several mA. The SYNC pin may be tied high for spread spectrum modulation mode, and the LT8609/LT8609A will operate similar to pulse-skipping mode but vary the clock frequency to reduce EMI.

Comparators on the LT8609/LT8609A/LT8609B adjustable output parts monitoring the FB pin voltage will pull the PG pin low if the output voltage varies more than ±8.5% (typical) from the set point, or if a fault condition is present. Comparators on the LT8609A-3.3/LT8609A-5 fixed output parts monitoring the V_{OUT} pin voltage will pull the PG pin low if the output voltage varies more than ±7.5% (typical) from the set point, or if a fault condition is present.

The oscillator reduces the LT8609/LT8609A's operating frequency when the voltage at the FB pin is low, or the voltage at the V_{OUT} pin is low on the LT8609A-3.3 or LT8609A-5 fixed voltage options. This frequency foldback helps to control the inductor current when the output voltage is lower than the programmed value which occurs during start-up. When a clock is applied to the SYNC pin the frequency foldback is disabled.

The LT8609B has no SYNC pin and only operates in pulse-skipping mode.

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APPLICATIONS INFORMATION

Achieving Ultralow Quiescent Current

To enhance efficiency at light loads, the LT8609/LT8609A enters into low ripple Burst Mode operation, which keeps the output capacitor charged to the desired output voltage while minimizing the input quiescent current and minimizing output voltage ripple. In Burst Mode operation the LT8609/LT8609A delivers single small pulses of current to the output capacitor followed by sleep periods where the output power is supplied by the output capacitor. While in sleep mode the LT8609/LT8609A consumes 1.7µA.

As the output load decreases, the frequency of single current pulses decreases (see Figure 1) and the percentage of time the LT8609/LT8609A is in sleep mode increases, resulting in much higher light load efficiency than for typical converters. By maximizing the time between pulses, the converter quiescent current approaches 2.5µA for a typical application when there is no output load. Therefore, to optimize the quiescent current performance at light loads, the current in the feedback resistor divider must be minimized as it appears to the output as load current.

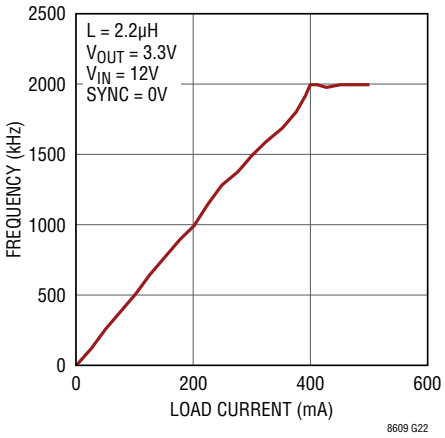

Figure 1a. SW Burst Mode Frequency vs Load

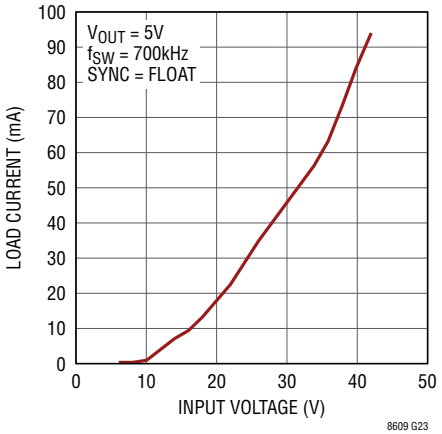

Figure 1b. Full Switching Frequency Minimum Load vs V_{IN} in Pulse Skipping Mode

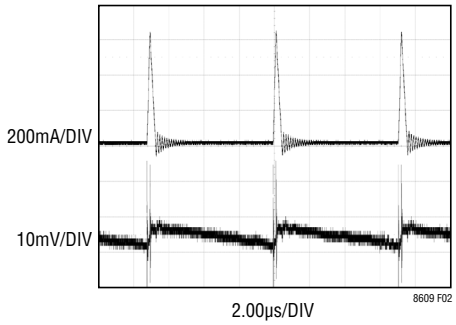

Figure 2. Burst Mode Operation

While in Burst Mode operation the current limit of the top switch is approximately 600mA resulting in output voltage ripple shown in Figure 2. Increasing the output capacitance will decrease the output ripple proportionally. As load ramps upward from zero the switching frequency will increase but only up to the switching frequency programmed by the resistor at the RT pin as shown in Table 1. The output load at which the LT8609/LT8609A reaches the programmed frequency varies based on input voltage, output voltage, and inductor choice.

For some applications, it is desirable for the LT8609/LT8609A to operate in pulse-skipping mode, which is the only mode available to the LT8609B. Pulse-skipping mode offers two major differences from Burst Mode operation. First is the clock stays awake at all times and all switching cycles are aligned to the clock. In this mode much of the internal circuitry is awake at all times, increasing quiescent current to several hundred µA. Second is that full switching frequency is reached at lower output load than in Burst Mode operation as shown in Figure 1b. To enable pulse-skipping mode the SYNC pin is floated. To achieve spread spectrum modulation with pulse-skipping mode, the SYNC pin is tied high. While a clock is applied to the SYNC pin the LT8609/LT8609A will also operate in pulse-skipping mode.

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APPLICATIONS INFORMATION

FB Resistor Network

The output voltage is programmed with a resistor divider between the output and the FB pin. Choose the resistor values according to:

$$R1 = R2\left(\frac{V_{OUT}}{0.782V} - 1\right)$$

1% resistors are recommended to maintain output voltage accuracy.

The total resistance of the FB resistor divider should be selected to be as large as possible when good low load efficiency is desired: The resistor divider generates a small load on the output, which should be minimized to optimize the quiescent current at low loads.

When using large FB resistors, a 10pF phase lead capacitor should be connected from V_{OUT} to FB.

The fixed output versions of the LT8609A have the feedback resistor network and phase lead capacitor integrated within the part. The FB pin is replaced with a V_{OUT} pin for these regulators. The V_{OUT} pin can be connected directly to the inductor and output capacitor. The LT8609A-3.3 regulates to 3.3V and has a total of 5.9M of internal feedback divider resistance from the V_{OUT} pin to ground. The LT8609A-5 regulates to 5V and has a total of 8.95M of internal feedback divider resistance from the V_{OUT} pin to ground.

Setting the Switching Frequency

The LT8609/LT8609A/LT8609B uses a constant frequency PWM architecture that can be programmed to switch from 200kHz to 2.2MHz by using a resistor tied from the RT pin to ground. A table showing the necessary R_T value for a desired switching frequency is in Table 1. When in spread spectrum modulation mode, the frequency is modulated upwards of the frequency set by R_T.

Table 1. SW Frequency vs RT Value

f_{SW} (MHz)	R_T (kΩ)
0.2	221
0.300	143
0.400	110
0.500	86.6
0.600	71.5
0.700	60.4
0.800	52.3
0.900	46.4
1.000	40.2
1.200	33.2
1.400	27.4
1.600	23.7
1.800	20.5
2.000	18.2
2.200	16.2

Operating Frequency Selection and Trade-Offs

Selection of the operating frequency is a trade-off between efficiency, component size, and input voltage range. The advantage of high frequency operation is that smaller inductor and capacitor values may be used. The disadvantages are lower efficiency and a smaller input voltage range.

The highest switching frequency ($f_{SW(MAX)}$) for a given application can be calculated as follows:

$$f_{SW(MAX)} = \frac{V_{OUT} + V_{SW(BOT)}}{t_{ON(MIN)}\left(V_{IN} - V_{SW(TOP)} + V_{SW(BOT)}\right)}$$

where V_{IN} is the typical input voltage, V_{OUT} is the output voltage, $V_{SW(TOP)}$ and $V_{SW(BOT)}$ are the internal switch drops (~0.4V, ~0.25V, respectively at max load) and $t_{ON(MIN)}$ is the minimum top switch on-time (see Typical Applications). This equation shows that slower switching frequency is necessary to accommodate a high V_{IN}/V_{OUT} ratio.

For transient operation V_{IN} may go as high as the Abs Max rating regardless of the RT value, however the LT8609/

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APPLICATIONS INFORMATION

LT8609A/LT8609B will reduce switching frequency as necessary to maintain control of inductor current to assure safe operation.

The LT8609/LT8609A/LT8609B is capable of maximum duty cycle approaching 100%, and the V_{IN} to V_{OUT} dropout is limited by the $R_{DS(ON)}$ of the top switch. In this mode the LT8609/LT8609A /LT8609B skips switch cycles, resulting in a lower switching frequency than programmed by R_T.

For applications that cannot allow deviation from the programmed switching frequency at low V_{IN}/V_{OUT} ratios use the following formula to set switching frequency:

$$V_{IN(MIN)} = \frac{V_{OUT} + V_{SW(BOT)}}{1 - f_{SW} \bullet t_{OFF(MIN)}} - V_{SW(BOT)} + V_{SW(TOP)}$$

where $V_{IN(MIN)}$ is the minimum input voltage without skipped cycles, V_{OUT} is the output voltage, $V_{SW(TOP)}$ and $V_{SW(BOT)}$ are the internal switch drops (~0.4V, ~0.25V, respectively at max load), f_{SW} is the switching frequency (set by RT), and $t_{OFF(MIN)}$ is the minimum switch off-time. Note that higher switching frequency will increase the minimum input voltage below which cycles will be dropped to achieve higher duty cycle.

Inductor Selection and Maximum Output Current

The LT8609/LT8609A/LT8609B is designed to minimize solution size by allowing the inductor to be chosen based on the output load requirements of the application. During overload or short circuit conditions the LT8609/LT8609A/LT8609B safely tolerates operation with a saturated inductor through the use of a high speed peak-current mode architecture.

A good first choice for the inductor value is:

$$L = \frac{V_{OUT} + V_{SW(BOT)}}{f_{SW}}$$

where f_{SW} is the switching frequency in MHz, V_{OUT} is the output voltage, $V_{SW(BOT)}$ is the bottom switch drop (~0.25V) and L is the inductor value in µH.

To avoid overheating and poor efficiency, an inductor must be chosen with an RMS current rating that is greater than the maximum expected output load of the application. In addition, the saturation current (typically labeled I_{SAT}) rating of the inductor must be higher than the load current plus 1/2 of in inductor ripple current:

$$I_{L(PEAK)} = I_{LOAD(MAX)} + \frac{1}{2}\Delta_L$$

where ΔI_L is the inductor ripple current as calculated several paragraphs below and $I_{LOAD(MAX)}$ is the maximum output load for a given application.

As a quick example, an application requiring 1A output should use an inductor with an RMS rating of greater than 1A and an I_{SAT} of greater than 1.3A. To keep the efficiency high, the series resistance (DCR) should be less than 0.04Ω, and the core material should be intended for high frequency applications.

The LT8609/LT8609A/LT8609B limits the peak switch current in order to protect the switches and the system from overload faults. The top switch current limit (I_{LIM}) is typically 4.75A at low duty cycles and decreases linearly to 4.0A at D = 0.8. The inductor value must then be sufficient to supply the desired maximum output current ($I_{OUT(MAX)}$), which is a function of the switch current limit (I_{LIM}) and the ripple current:

$$I_{OUT(MAX)} = I_{LIM} - \frac{\Delta I_L}{2}$$

The peak-to-peak ripple current in the inductor can be calculated as follows:

$$\Delta I_L = \frac{V_{OUT}}{L \bullet f_{SW}} \left(1 - \frac{V_{OUT}}{V_{IN(MAX)}}\right)$$

where f_{SW} is the switching frequency of the LT8609/LT8609A/LT8609B, and L is the value of the inductor. Therefore, the maximum output current that the LT8609/LT8609A/LT8609B will deliver depends on minimum the switch current limit, the inductor value, and the input and output voltages. The inductor value may have to be increased if the inductor ripple current does not allow sufficient maximum output current ($I_{OUT(MAX)}$) given the switching frequency, and maximum input voltage used in the desired application.

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APPLICATIONS INFORMATION

The optimum inductor for a given application may differ from the one indicated by this design guide. A larger value inductor provides a higher maximum load current and reduces the output voltage ripple. For applications requiring smaller load currents, the value of the inductor may be lower and the LT8609/LT8609A/LT8609B may operate with higher ripple current. This allows use of a physically smaller inductor, or one with a lower DCR resulting in higher efficiency. Be aware that low inductance may result in discontinuous mode operation, which further reduces maximum load current.

For more information about maximum output current and discontinuous operation, see Application Note 44.

Finally, for duty cycles greater than 50% ($V_{OUT}/V_{IN} > 0.5$), a minimum inductance is required to avoid sub-harmonic oscillation. See Application Note 19.

Input Capacitor

Bypass the input of the LT8609/LT8609A/LT8609B circuit with a ceramic capacitor of X7R or X5R type. Y5V types have poor performance over temperature and applied voltage, and should not be used. A 4.7µF to 10µF ceramic capacitor is adequate to bypass the LT8609/LT8609A/LT8609B and will easily handle the ripple current. Note that larger input capacitance is required when a lower switching frequency is used. If the input power source has high impedance, or there is significant inductance due to long wires or cables, additional bulk capacitance may be necessary. This can be provided with a low performance electrolytic capacitor.

Step-down regulators draw current from the input supply in pulses with very fast rise and fall times. The input capacitor is required to reduce the resulting voltage ripple at the LT8609/LT8609A/LT8609B and to force this very high frequency switching current into a tight local loop, minimizing EMI. A 4.7µF capacitor is capable of this task, but only if it is placed close to the LT8609/LT8609A/LT8609B (see the PCB Layout section). A second precaution regarding the ceramic input capacitor concerns the maximum input voltage rating of the LT8609/LT8609A/LT8609B. A ceramic input capacitor combined with trace or cable inductance forms a high quality (under damped) tank circuit. If the LT8609/LT8609A/LT8609B circuit is plugged into a live supply, the input voltage can ring to twice its nominal value, possibly exceeding the LT8609/LT8609A/LT8609B's voltage rating. This situation is easily avoided (see Analog Devices Application Note 88).

Output Capacitor and Output Ripple

The output capacitor has two essential functions. Along with the inductor, it filters the square wave generated by the LT8609/LT8609A/LT8609B to produce the DC output. In this role it determines the output ripple, thus low impedance at the switching frequency is important. The second function is to store energy in order to satisfy transient loads and stabilize the LT8609/LT8609A/LT8609B's control loop. Ceramic capacitors have very low equivalent series resistance (ESR) and provide the best ripple performance. A good starting value is:

$$C_{OUT} = \frac{100}{V_{OUT} \bullet f_{SW}}$$

where f_{SW} is in MHz, and C_{OUT} is the recommended output capacitance in µF. Use X5R or X7R types. This choice will provide low output ripple and good transient response. Transient performance of adjustable output parts can be improved with a higher value output capacitor and the addition of a feedforward capacitor placed between V_{OUT} and FB. Increasing the output capacitance will also decrease the output voltage ripple. A lower value of output capacitor can be used to save space and cost but transient performance will suffer and may cause loop instability. See the Typical Applications in this data sheet for suggested capacitor values.

When choosing a capacitor, special attention should be given to the data sheet to calculate the effective capacitance under the relevant operating conditions of voltage bias and temperature. A physically larger capacitor or one with a higher voltage rating may be required.

Ceramic Capacitors

Ceramic capacitors are small, robust and have very low ESR. However, ceramic capacitors can cause problems when used with the LT8609/LT8609A/LT8609B due to their piezoelectric nature. When in Burst Mode operation, the LT8609/LT8609A/LT8609B's switching frequency depends on the load current, and at very

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APPLICATIONS INFORMATION

light loads the LT8609/LT8609A/LT8609B can excite the ceramic capacitor at audio frequencies, generating audible noise. Since the LT8609/LT8609A/LT8609B operates at a lower current limit during Burst Mode operation, the noise is typically very quiet to a casual ear. If this is unacceptable, use a high performance tantalum or electrolytic capacitor at the output.

A final precaution regarding ceramic capacitors concerns the maximum input voltage rating of the LT8609/LT8609A/LT8609B. As previously mentioned, a ceramic input capacitor combined with trace or cable inductance forms a high quality (under damped) tank circuit. If the LT8609/LT8609A/LT8609B circuit is plugged into a live supply, the input voltage can ring to twice its nominal value, possibly exceeding the LT8609/LT8609A/LT8609B's rating. This situation is easily avoided (see Application Note 88).

Enable Pin

The LT8609/LT8609A/LT8609B is in shutdown when the EN pin is low and active when the pin is high. The rising threshold of the EN comparator is 1.05V, with 50mV of hysteresis. The EN pin can be tied to V_{IN} if the shutdown feature is not used, or tied to a logic level if shutdown control is required.

Adding a resistor divider from V_{IN} to EN programs the LT8609/LT8609A/LT8609B to regulate the output only when V_{IN} is above a desired voltage (see Block Diagram). Typically, this threshold, $V_{IN(EN)}$, is used in situations where the input supply is current limited, or has a relatively high source resistance. A switching regulator draws constant power from the source, so source current increases as source voltage drops. This looks like a negative resistance load to the source and can cause the source to current limit or latch low under low source voltage conditions. The $V_{IN(EN)}$ threshold prevents the regulator from operating at source voltages where the problems might occur. This threshold can be adjusted by setting the values R3 and R4 such that they satisfy the following equation:

$$V_{IN(EN)} = \left(\frac{R3}{R4} + 1\right) \bullet 1V$$

where the LT8609/LT8609A/LT8609B will remain off until V_{IN} is above $V_{IN(EN)}$. Due to the comparator's hysteresis, switching will not stop until the input falls slightly below $V_{IN(EN)}$.

When in Burst Mode operation for light-load currents, the current through the $V_{IN(EN)}$ resistor network can easily be greater than the supply current consumed by the LT8609/LT8609A/LT8609B. Therefore, the $V_{IN(EN)}$ resistors should be large to minimize their effect on efficiency at low loads.

$INTV_{CC}$ Regulator

An internal low dropout (LDO) regulator produces the 3.5V supply from V_{IN} that powers the drivers and the internal bias circuitry. The $INTV_{CC}$ can supply enough current for the LT8609/LT8609A/LT8609B's circuitry and must be bypassed to ground with a minimum of 1µF ceramic capacitor. Good bypassing is necessary to supply the high transient currents required by the power MOSFET gate drivers. Applications with high input voltage and high switching frequency will increase die temperature because of the higher power dissipation across the LDO. Do not connect an external load to the $INTV_{CC}$ pin.

Output Voltage Tracking and Soft-Start

The LT8609/LT8609A/LT8609B allows the user to program its output voltage ramp rate by means of the TR/SS pin. An internal 2µA pulls up the TR/SS pin to $INTV_{CC}$. Putting an external capacitor on TR/SS enables soft-starting the output to prevent current surge on the input supply. During the soft-start ramp the output voltage will proportionally track the TR/SS pin voltage. For output tracking applications, TR/SS can be externally driven by another voltage source. From 0V to 0.782V, the TR/SS voltage will override the internal 0.782V reference input to the error amplifier, thus regulating the FB pin voltage to that of TR/SS pin. In the LT8609A-3.3 and LT8609A-5 fixed output voltage options the output voltage will track the TR/SS pin voltage based on a factor set by the internal feedback resistor divider. The 3.3V output options will track to a voltage 4.2 times that of the TR/SS pin, while the 5V output options will track to a voltage 6.39 times that of the TR/SS pin. When

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APPLICATIONS INFORMATION

TR/SS is above 0.782V, tracking is disabled and the feedback voltage will regulate to the internal reference voltage.

An active pull-down circuit is connected to the TR/SS pin which will discharge the external soft-start capacitor in the case of fault conditions and restart the ramp when the faults are cleared. Fault conditions that clear the soft-start capacitor are the EN/UV pin transitioning low, V_{IN} voltage falling too low, or thermal shutdown.

Output Power Good

When the LT8609/LT8609A/LT8609B's adjustable output voltage is within the ±8.5% window of the regulation point, which is a V_{FB} voltage in the range of 0.716V to 0.849V (typical), the output voltage is considered good and the open-drain PG pin goes high impedance and is typically pulled high with an external resistor. Otherwise, the internal drain pull-down device will pull the PG pin low. To prevent glitching both the upper and lower thresholds include 0.5% of hysteresis. The LT8609A-3.3 and LT8609A-5 use a ±7.5% power good window around the regulation point, which for the 3.3V output version corresponds to a 3.0525V to 3.5475V range (typical) and for the 5V output version corresponds to a 4.625V to 5.375V range (typical).

The PG pin is also actively pulled low during several fault conditions: EN/UV pin is below 1V, $INTV_{CC}$ has fallen too low, V_{IN} is too low, or thermal shutdown.

Synchronization

To select low ripple Burst Mode operation, tie the SYNC pin below 0.4V (this can be ground or a logic low output). To synchronize the LT8609/LT8609A oscillator to an external frequency connect a square wave (with 20% to 80% duty cycle) to the SYNC pin. The square wave amplitude should have valleys that are below 0.9V and peaks above 2.7V (up to 5V).

The LT8609/LT8609A will not enter Burst Mode operation at low output loads while synchronized to an external clock, but instead will pulse skip to maintain regulation. The LT8609/LT8609A may be synchronized over a 200kHz to 2.2MHz range. The R_T resistor should be chosen to set the LT8609/LT8609A switching frequency equal to or below the lowest synchronization input. For example, if the synchronization signal will be 500kHz and higher, the R_T should be selected for 500kHz. The slope compensation is set by the R_T value, while the minimum slope compensation required to avoid subharmonic oscillations is established by the inductor size, input voltage, and output voltage. Since the synchronization frequency will not change the slopes of the inductor current waveform, if the inductor is large enough to avoid subharmonic oscillations at the frequency set by RT, then the slope compensation will be sufficient for all synchronization frequencies.

For some applications, it is desirable for the LT8609/LT8609A to operate in pulse-skipping mode, which is the only mode available to the LT8609B. Pulse-skipping mode offers two major differences from Burst Mode operation. First is the clock stays awake at all times and all switching cycles are aligned to the clock. Second is that full switching frequency is reached at lower output load than in Burst Mode operation as shown in Figure 1b in an earlier section. These two differences come at the expense of increased quiescent current. To enable pulse-skipping mode the SYNC pin is floated.

For some applications, reduced EMI operation may be desirable, which can be achieved through spread spectrum modulation. This mode operates similar to pulse skipping mode operation, with the key difference that the switching frequency is modulated up and down by a 3kHz triangle wave. The modulation has the frequency set by RT as the low frequency, and modulates up to approximately 20% higher than the frequency set by RT. To enable spread spectrum mode, tie SYNC to $INTV_{CC}$ or drive to a voltage between 3.2V and 5V.

The LT8609/LT8609A/LT8609B does not operate in forced continuous mode regardless of SYNC signal.

Shorted and Reversed Input Protection

The LT8609/LT8609A/LT8609B will tolerate a shorted output. Several features are used for protection during output short-circuit and brownout conditions. The first is the switching frequency will be folded back while the output is lower than the set point to maintain inductor current control. Second, the bottom switch current is monitored such that if inductor current is beyond safe levels

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APPLICATIONS INFORMATION

switching of the top switch will be delayed until such time as the inductor current falls to safe levels. This allows for tailoring the LT8609/LT8609A/LT8609B to individual applications and limiting thermal dissipation during short circuit conditions.

Frequency foldback behavior depends on the state of the SYNC pin: If the SYNC pin is low or high, or floated the switching frequency will slow while the output voltage is lower than the programmed level. If the SYNC pin is connected to a clock source, the LT8609/LT8609A/LT8609B will stay at the programmed frequency without foldback and only slow switching if the inductor current exceeds safe levels.

There is another situation to consider in systems where the output will be held high when the input to the LT8609/LT8609A/LT8609B is absent. This may occur in battery charging applications or in battery backup systems where a battery or some other supply is diode ORed with the LT8609/LT8609A/LT8609B's output. If the V_{IN} pin is allowed to float and the EN pin is held high (either by a logic signal or because it is tied to V_{IN}), then the LT8609/LT8609A/LT8609B's internal circuitry will pull its quiescent current through its SW pin. This is acceptable if the system can tolerate several µA in this state. If the EN pin is grounded the SW pin current will drop to near 0.7µA. However, if the V_{IN} pin is grounded while the output is held high, regardless of EN, parasitic body diodes inside the LT8609/LT8609A/LT8609B can pull current from the output through the SW pin and the V_{IN} pin. Figure 3 shows a connection of the V_{IN} and EN/UV pins that will allow the LT8609/LT8609A/LT8609B to run only when the input voltage is present and that protects against a shorted or reversed input.

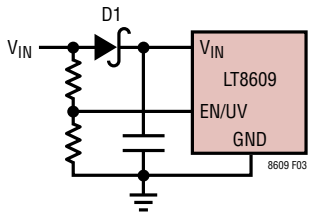

Figure 3. Reverse V_{IN} Protection

PCB Layout

For proper operation and minimum EMI, care must be taken during printed circuit board layout. Figure 4 shows the recommended component placement with trace, ground plane and via locations. Note that large, switched currents flow in the LT8609/LT8609A/LT8609B's V_{IN} pins, GND pins, and the input capacitor (C_{IN}). The loop formed by the input capacitor should be as small as possible by placing the capacitor adjacent to the V_{IN} and GND pins. When using a physically large input capacitor the resulting loop may become too large in which case using a small case/value capacitor placed close to the V_{IN} and GND pins plus a larger capacitor further away is preferred. These components, along with the inductor and output capacitor, should be placed on the same side of the circuit board, and their connections should be made on that layer. Place a local, unbroken ground plane under the application circuit on the layer closest to the surface layer. The SW and BOOST nodes should be as small as possible. Finally, keep the FB and RT nodes small so that the ground traces will shield them from the SW and BOOST nodes. The exposed pad on the bottom of the package must be soldered to ground so that the pad is connected to ground electrically and also acts as a heat sink thermally. To keep thermal resistance low, extend the ground plane as much as possible, and add thermal vias under and near the LT8609/LT8609A/LT8609B to additional ground planes within the circuit board and on the bottom side.

Thermal Considerations and Peak Current Output

For higher ambient temperatures, care should be taken in the layout of the PCB to ensure good heat sinking of the LT8609/LT8609A/LT8609B. The exposed pad on the bottom of the package must be soldered to a ground plane. This ground should be tied to large copper layers below with thermal vias; these layers will spread heat dissipated by the LT8609/LT8609A/LT8609B. Placing additional vias can reduce thermal resistance further. The maximum load current should be derated as the ambient temperature approaches the maximum junction rating.

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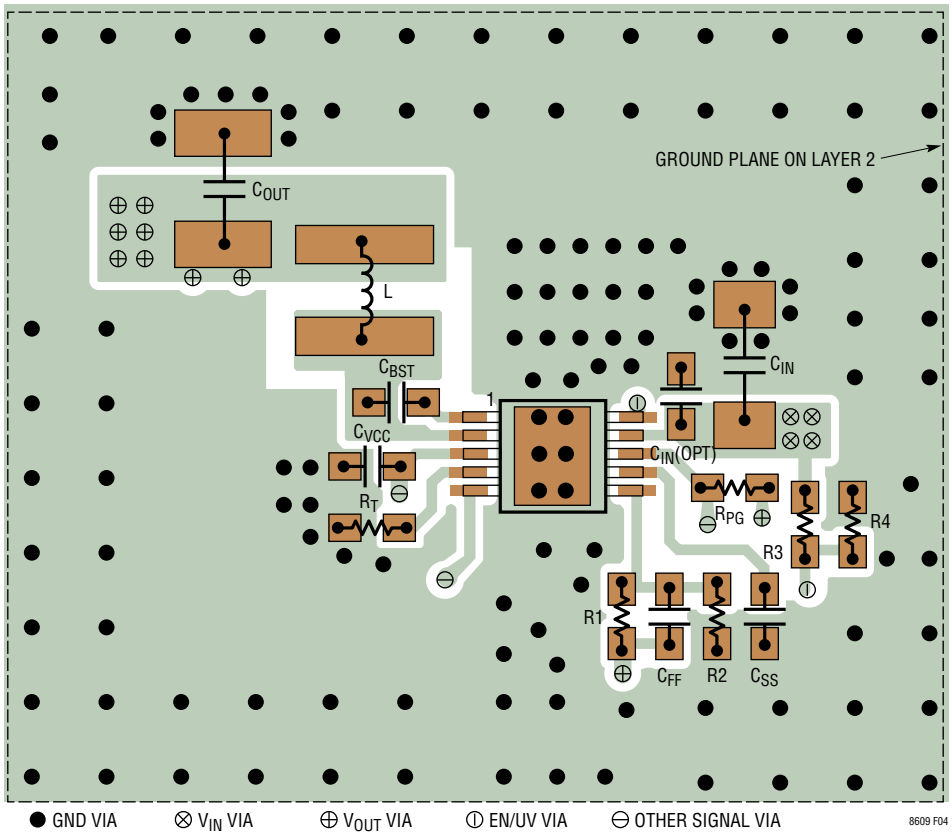

Figure 4. PCB Layout

Power dissipation within the LT8609/LT8609A/LT8609B can be estimated by calculating the total power loss from an efficiency measurement and subtracting the inductor loss. The die temperature is calculated by multiplying the LT8609/LT8609A/LT8609B power dissipation by the thermal resistance from junction to ambient. The LT8609/LT8609A/LT8609B will stop switching and indicate a fault condition if safe junction temperature is exceeded.

Temperature rise of the LT8609/LT8609A/LT8609B is worst when operating at high load, high V_{IN}, and high switching frequency. If the case temperature is too high for a given application, then either V_{IN}, switching frequency or load current can be decreased to reduce the temperature to an acceptable level. Figure 5 shows how case temperature rise can be managed by reducing V_{IN}.

Figure 6 shows an example of how case temperature rise changes with the duty cycle of a 10Hz pulsed 3A load. Junction temperature will be higher than case temperature.

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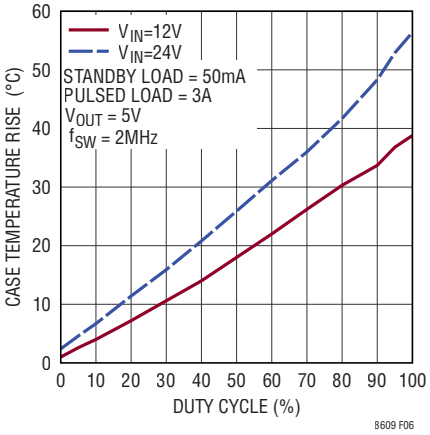


Figure 5. Case Temperature Rise vs Load Current

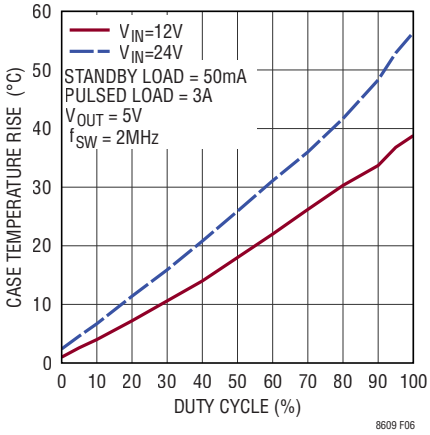
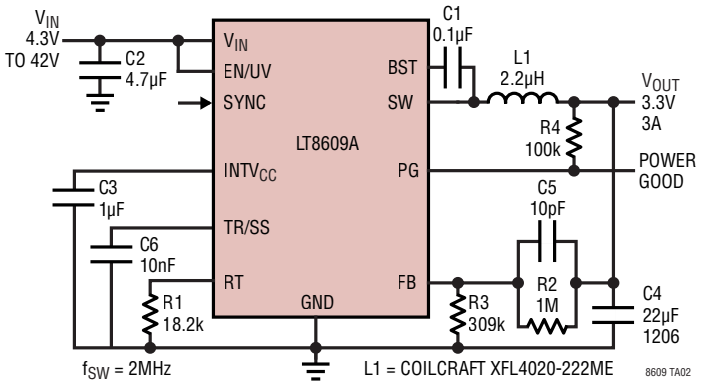


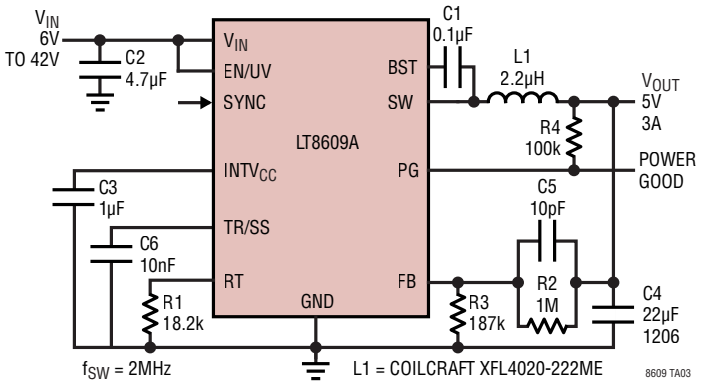
Figure 6. Case Temperature Rise vs 3A Pulsed Load

TYPICAL APPLICATIONS

3.3V Step-Down



5V Step-Down



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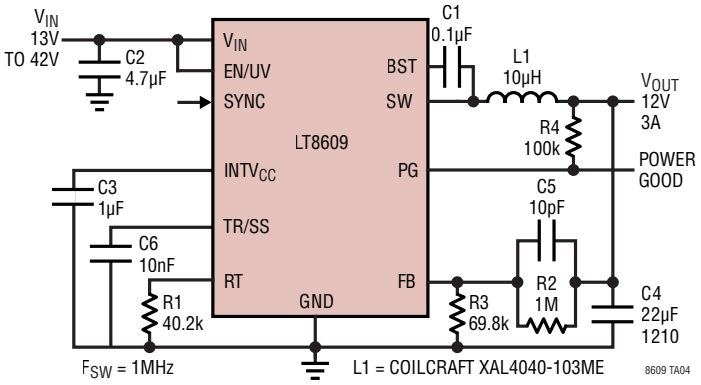
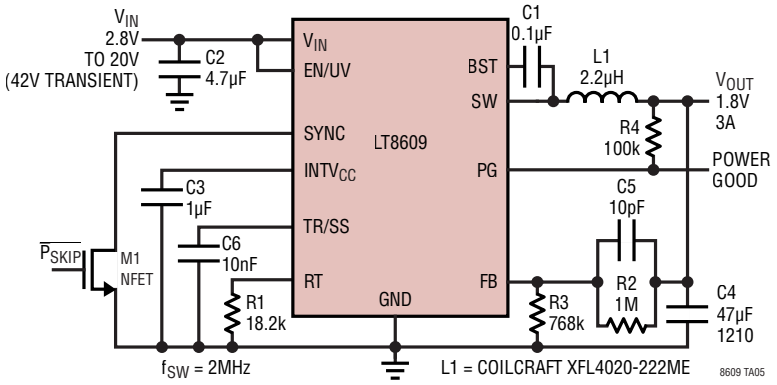
TYPICAL APPLICATIONS

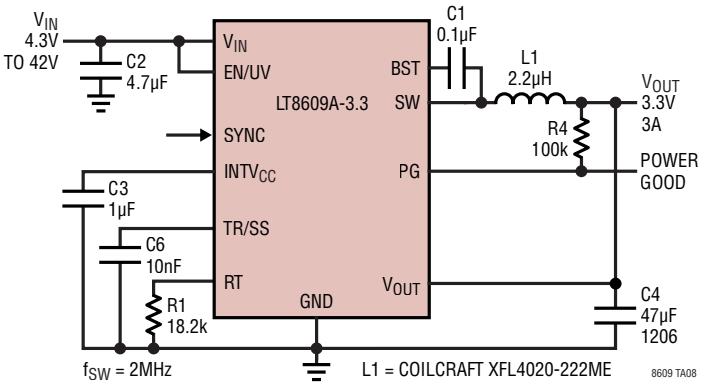
12V Step-Down



1.8V 2MHz Step-Down Converter



3.3V 2MHz Step-Down Converter



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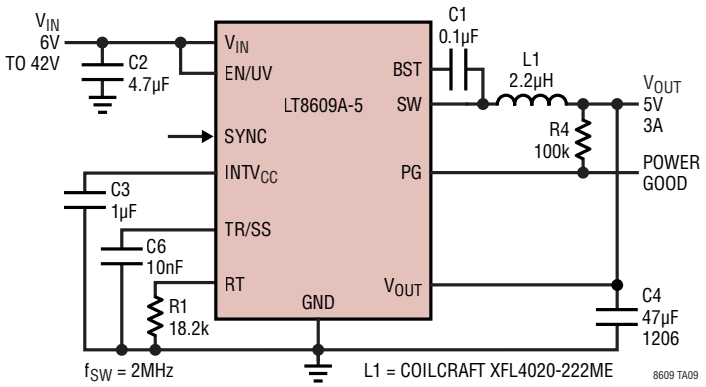
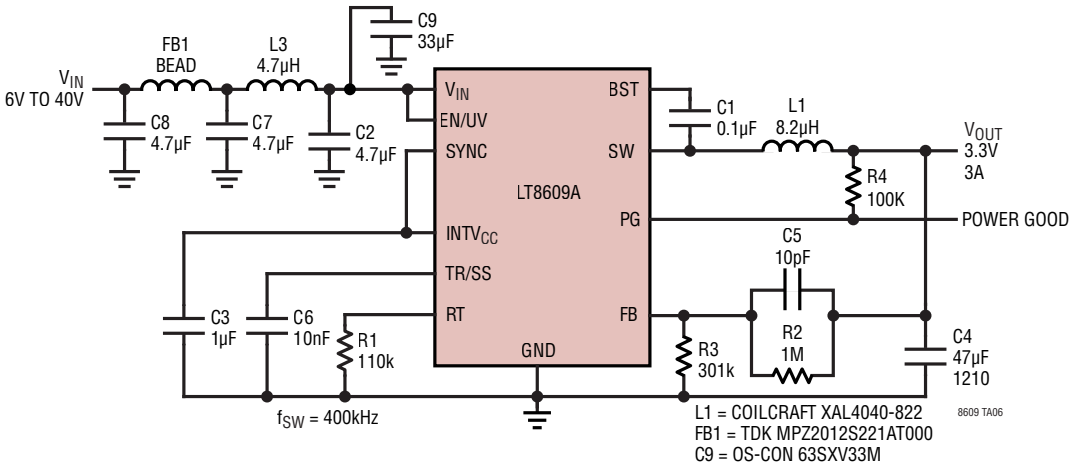
TYPICAL APPLICATIONS

5V 2MHz Step-Down Converter



Ultralow EMI 5V 2A Step-Down Converter



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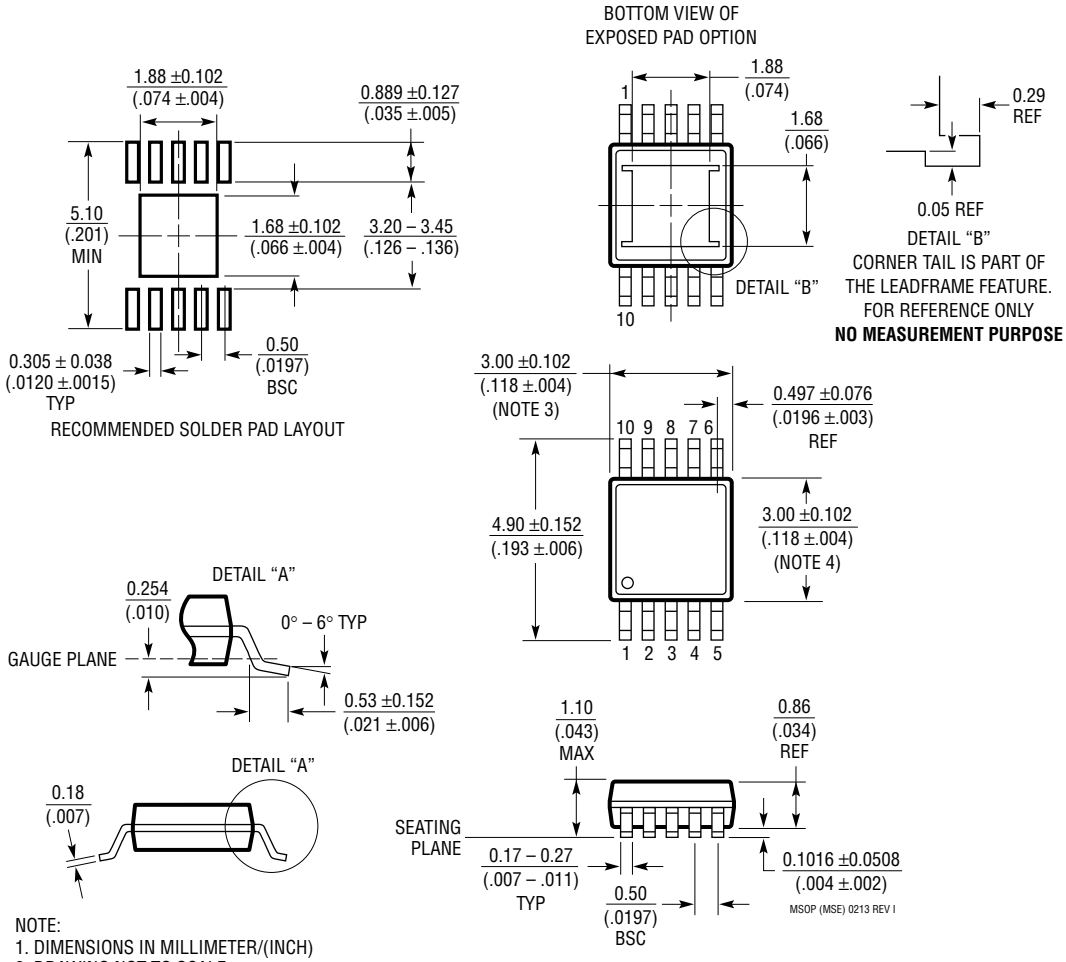
PACKAGE DESCRIPTION

MSE Package
10-Lead Plastic MSOP, Exposed Die Pad
(Reference LTC DWG # 05-08-1664 Rev I)



NOTE:
1. DIMENSIONS IN MILLIMETER/(INCH)
2. DRAWING NOT TO SCALE
3. DIMENSION DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
   MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.152mm (.006") PER SIDE
4. DIMENSION DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSIONS.
   INTERLEAD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.152mm (.006") PER SIDE
5. LEAD COPLANARITY (BOTTOM OF LEADS AFTER FORMING) SHALL BE 0.102mm (.004") MAX
6. EXPOSED PAD DIMENSION DOES INCLUDE MOLD FLASH. MOLD FLASH ON E-PAD
   SHALL NOT EXCEED 0.254mm (.010") PER SIDE.

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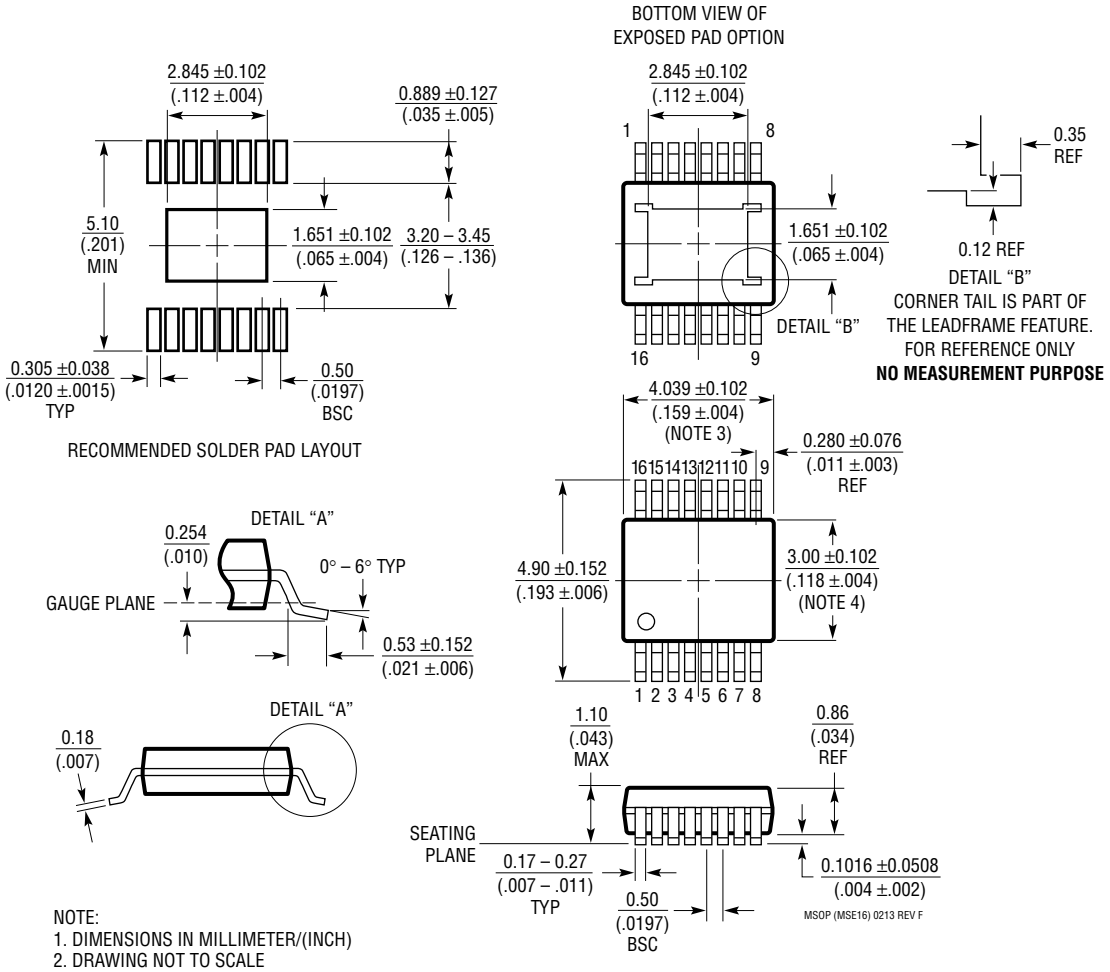
PACKAGE DESCRIPTION

MSE Package
16-Lead Plastic MSOP, Exposed Die Pad
(Reference LTC DWG # 05-08-1667 Rev F)



NOTE:
1. DIMENSIONS IN MILLIMETER/(INCH)
2. DRAWING NOT TO SCALE
3. DIMENSION DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
   MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.152mm (.006") PER SIDE
4. DIMENSION DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSIONS.
   INTERLEAD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.152mm (.006") PER SIDE
5. LEAD COPLANARITY (BOTTOM OF LEADS AFTER FORMING) SHALL BE 0.102mm (.004") MAX
6. EXPOSED PAD DIMENSION DOES INCLUDE MOLD FLASH. MOLD FLASH ON E-PAD SHALL
   NOT EXCEED 0.254mm (.010") PER SIDE.

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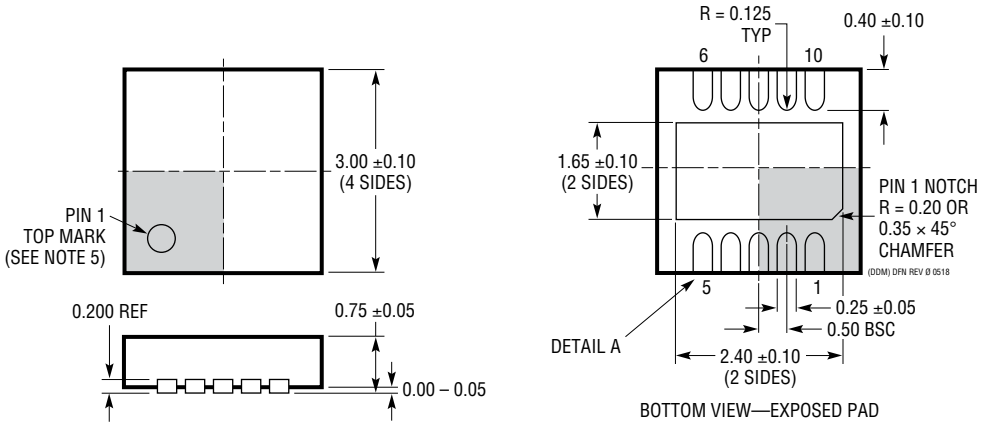
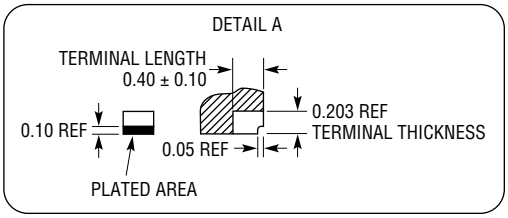
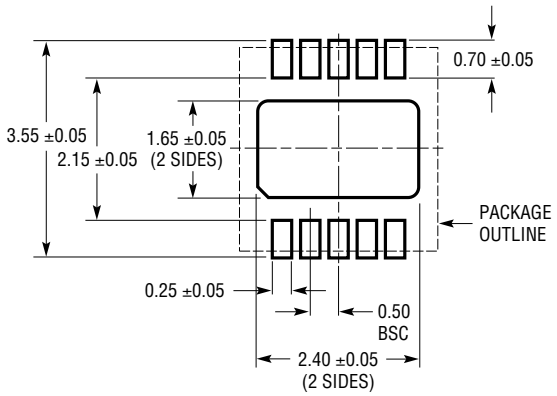
PACKAGE DESCRIPTION

DDM Package
10-Lead Plastic Side Wettable DFN (3mm × 3mm)
(Reference LTC DWG # 05-08-1647 Rev Ø)



NOTE:
1. DRAWING NOT TO SCALE
2. ALL DIMENSIONS ARE IN MILLIMETERS
3. DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.15mm ON ANY SIDE
4. EXPOSED PAD SHALL BE SOLDER PLATED
5. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION ON THE TOP AND BOTTOM OF PACKAGE





RECOMMENDED SOLDER PAD PITCH AND DIMENSIONS

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REVISION HISTORY

REV	DATE	DESCRIPTION	PAGE NUMBER
A	01/16	Added the LT8609A Version to Header	All
		Added the LT8609A Version to Description	1
		Clarified Description	1
		Clarified Electrical Specifications	3
		Clarified Load Regulation, Line Regulation, No-Load Supply Current vs Temperature, Minimum On-Time vs Temperature Graphs, Frequency Foldback and Soft-Start vs Temperature Graphs	5, 6, 7, 8
		Clarified Block Diagram with Optional Input Resistors	10
		Replaced Figure 1 with Table 1 in text	12
		Clarified C_{IN} Capacitor in Text and PCB Layout	18
		Clarified Typical Application	24
B	06/16	Clarified Switch Drop vs Switch Current Graph axis units	6
		Clarified Switching Waveforms conditions	8
C	10/16	Added LT8609B Option	All
		Added LT8609B Option to Absolute Maximum Ratings, Added LT8609B Package Drawing and Ordering Information	2
		Clarified Electrical Parameters and Notes for LT8609B Option	3
		Clarified Top FET Current Limit vs Temperature Graph	6
		Clarified Pin Functions to Include LT8609B	10
		Clarified Operation Section to Include LT8609B	12
		Clarified Applications Information Section to Include LT8609B	13 – 20
		Clarified Graphs in Figure 5 and 6	20
		Clarified Typical Applications Schematics	21, 22, 23, 24
D	01/17	Clarified Graphs	6, 7, 20
		Clarified Schematics	23, 26
E	06/17	Add H-grade to the A version	2, 4
		Modified application circuits	21, 22, 23
F	11/17	Clarified Oscillator Frequency R_T Conditions	3
		Clarified Minimum Off Time	3
		Clarified Efficiency Graph	5
		Clarified Frequency Foldback Graph	8
		Clarified Block Diagram	11
		Clarified Maximum Duty Cycle	14
		Clarified Figure 4	19
G	01/18	Added MSOP-16E Package option	1, 2, 24
		Clarified the Pin Functions	10

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REVISION HISTORY

REV	DATE	DESCRIPTION	PAGE NUMBER
H	02/19	Changed 2A/3A to 3A.	1
		Replaced all graphs with I_{OUT} to 3A.	1, 5, 6, 7, 8
		Added LT8609AJMSE16 and LT8609AJMSE options.	2
		Eliminated “The internal circuitry…” paragraph.	15
		Clarified Figure 4 PCB Layout.	19
		Clarified Figure 5.	20
		Eliminated “The LT8609/LT8609A/LT8609B’s…” paragraph.	20
		Updated Typical Applications.	21, 22
I	01/20	Added DFN version parts and J Grades.	1, 2, 3
		Clarified parametric table.	4, 5
		Added fixed output graphs.	6, 7 ,8
		Clarified Pin Functions.	11
		Clarified Block Diagram.	12
		Clarified Operation to include fixed output options.	13
		Added text for fixed output options.	15
		Added text in Output Capacitor and Output Ripple for fixed output options.	17
		Added text in Output Voltage Tracking section for fixed output options.	18
		Added text in Output Power Good section for fixed output options.	19
		Clarified Typical Applications.	22-25
J	08/21	Clarified Output Reference Voltage for LT8609A-3.3 and Line Regulations under Electrical Characteristics table.	4

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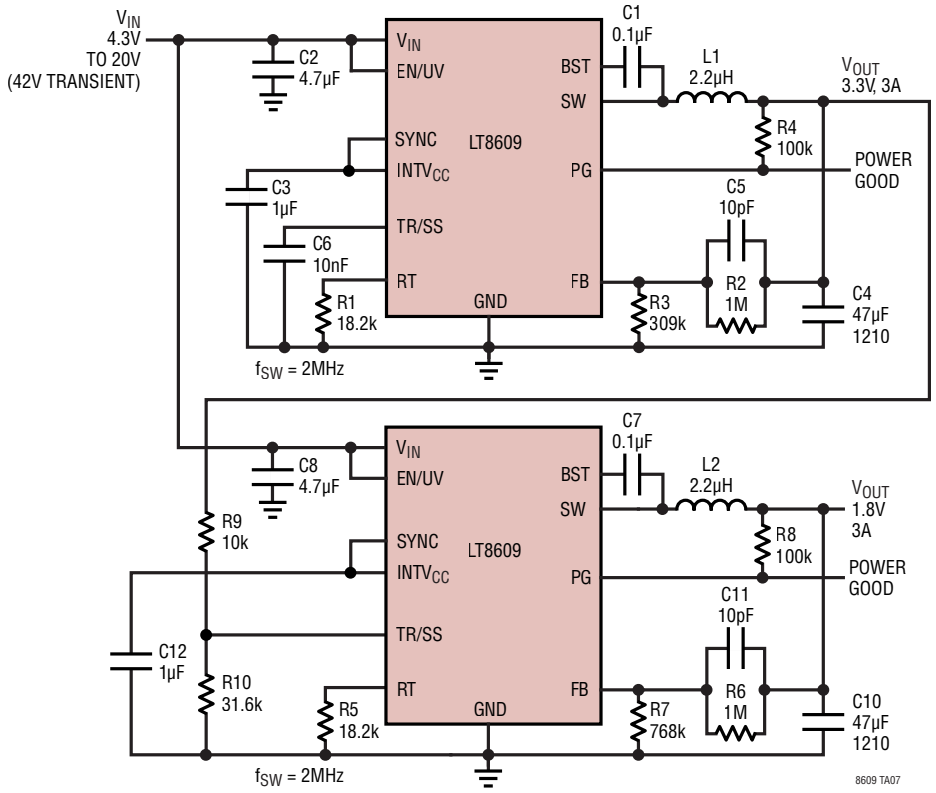
TYPICAL APPLICATION

Tracking 3.3V and 1.8V 2MHz Converters



RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LT8610A/ LT8610AB	42V, 3.5A, 96% Efficiency, 2.2MHz Synchronous MicroPower Step-Down DC/DC Converter with I_Q = 2.5µA	V_{IN} = 3.4V to 42V, $V_{OUT(MIN)}$ = 0.97V, I_Q = 2.5µA, I_{SD} < 1µA, MSOP-16E Package
LT8610AC	42V, 3.5A, 96% Efficiency, 2.2MHz Synchronous MicroPower Step-Down DC/DC Converter with I_Q = 2.5µA	V_{IN} = 3V to 42V, $V_{OUT(MIN)}$ = 0.8V, I_Q = 2.5µA, I_{SD} < 1µA, MSOP-16E Package
LT8610	42V, 2.5A, 96% Efficiency, 2.2MHz Synchronous MicroPower Step-Down DC/DC Converter with I_Q = 2.5µA	V_{IN} = 3.4V to 42V, $V_{OUT(MIN)}$ = 0.97V, I_Q = 2.5µA, I_{SD} < 1µA, MSOP-16E Package
LT8611	42V, 2.5A, 96% Efficiency, 2.2MHz Synchronous MicroPower Step-Down DC/DC Converter with I_Q = 2.5µA and Input/Output Current Limit/Monitor	V_{IN} = 3.4V to 42V, $V_{OUT(MIN)}$ = 0.97V, I_Q = 2.5µA, I_{SD} < 1µA, 3mm × 5mm QFN-24 Package
LT8616	42V, Dual 2.5A + 1.5A, 95% Efficiency, 2.2MHz Synchronous MicroPower Step-Down DC/DC Converter with I_Q = 5µA	V_{IN} = 3.4V to 42V, $V_{OUT(MIN)}$ = 0.8V, I_Q = 5µA, I_{SD} < 1µA, TSSOP-28E, 3mm × 6mm QFN-28 Packages
LT8620	65V, 2.5A, 96% Efficiency, 2.2MHz Synchronous MicroPower Step-Down DC/DC Converter with I_Q = 2.5µA	V_{IN} = 3.4V to 65V, $V_{OUT(MIN)}$ = 0.97V, I_Q = 2.5µA, I_{SD} < 1µA, MSOP-16E, 3mm × 5mm QFN-24 Packages
LT8614	42V, 4A, 96% Efficiency, 2.2MHz Synchronous MicroPower Step-Down DC/DC Converter with I_Q = 2.5µA	V_{IN} = 3.4V to 42V, $V_{OUT(MIN)}$ = 0.97V, I_Q = 2.5µA, I_{SD} < 1µA, 3mm × 4mm QFN-18 Package
LT8612	42V, 6A, 96% Efficiency, 2.2MHz Synchronous MicroPower Step-Down DC/DC Converter with I_Q = 2.5µA	V_{IN} = 3.4V to 42V, $V_{OUT(MIN)}$ = 0.97V, I_Q = 3.0µA, I_{SD} < 1µA, 3mm × 6mm QFN-28 Package
LT8640	42V, 5A/7A Peak, 96% Efficiency, 3MHz Synchronous MicroPower Step-Down DC/DC Converter with I_Q = 2.5µA	V_{IN} = 3.4V to 42V, $V_{OUT(MIN)}$ = 0.97V, I_Q = 2.5µA, I_{SD} < 1µA, 3mm × 4mm QFN-18 Package
LT8602	42V, Quad Output (2.5A+1.5A+1.5A+1.5A) 95% Efficiency, 2.2MHz Synchronous MicroPower Step-Down DC/DC Converter with I_Q = 25µA	V_{IN} = 3V to 42V, $V_{OUT(MIN)}$= 0.8V, I_Q = 25µA, I_{SD} < 1µA, 6mm × 6mm QFN-40 Package

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